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| Title | <i>Reference Design Report for a Dual Output 17.5 W Power Supply Using InnoSwitch™ - EP INN2904K</i> |
| Specification | 85 VAC – 484 VAC Input; 12 V, 1.25 A and 5 V, 0.5 A Outputs |
| Application | Embedded Power Supply |
| Author | Applications Engineering Department |
| Document Number | RDR-531 |
| Date | September 7, 2016 |
| Revision | 1.3 |

Summary and Features

- InnoSwitch-EP - industry first AC/DC ICs with isolated, safety rated integrated feedback
 - 900 V rated MOSFET
- Built in synchronous rectification for higher efficiency
- All the benefits of secondary side control with the simplicity of primary side regulation
 - Insensitive to transformer variation
 - Extremely fast transient response independent of load timing
- Meets output cross regulation requirements without linear regulators
- Primary sensed output overvoltage protection (OVP) eliminates optocoupler for fault protection
- Accurate thermal protection with hysteretic shutdown
- Input voltage monitor with accurate brown-in/brown-out and overvoltage protection

PATENT INFORMATION

The products and applications illustrated herein (including transformer construction and circuits external to the products) may be covered by one or more U.S. and foreign patents, or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at www.powerint.com. Power Integrations grants its customers a license under certain patent rights as set forth at <http://www.powerint.com/ip.htm>.

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Important Note:

Although this board is designed to satisfy safety isolation requirements, the engineering prototype has not been agency approved. Therefore, all testing should be performed using an isolation transformer to provide the AC input to the prototype board.



1 Introduction

This document is an engineering report describing a 1.25 A, 12 V and 0.5 A, 5 V dual output embedded power supply utilizing the INN2904K, with a 900 V rated MOSFET, from the InnoSwitch-EP family of ICs.

This design shows the high power density and efficiency that is possible due to the high level of integration while still providing exceptional performance.

The document contains the power supply specification, schematic, bill of materials, transformer documentation, printed circuit layout, and performance data.

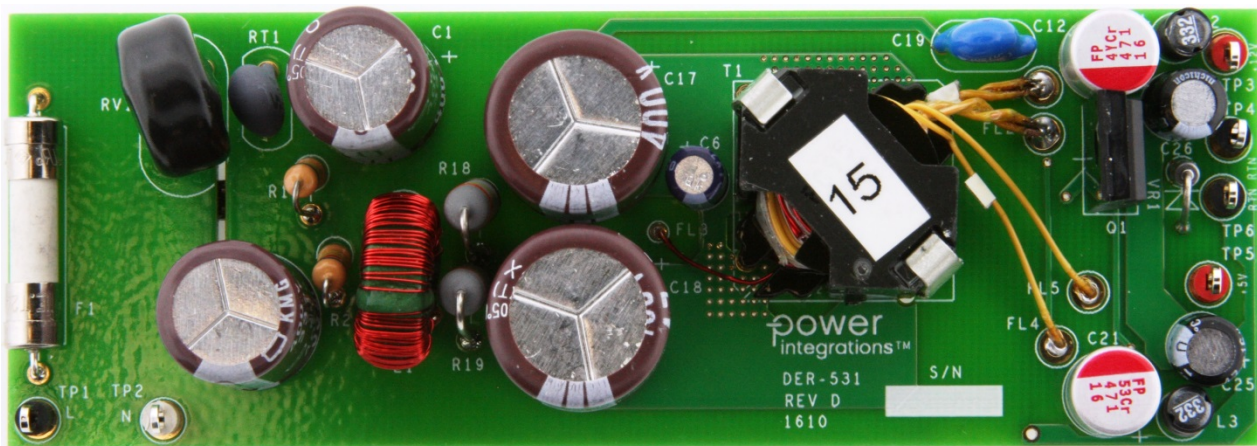


Figure 1 – Populated Circuit Board Photograph, Top.

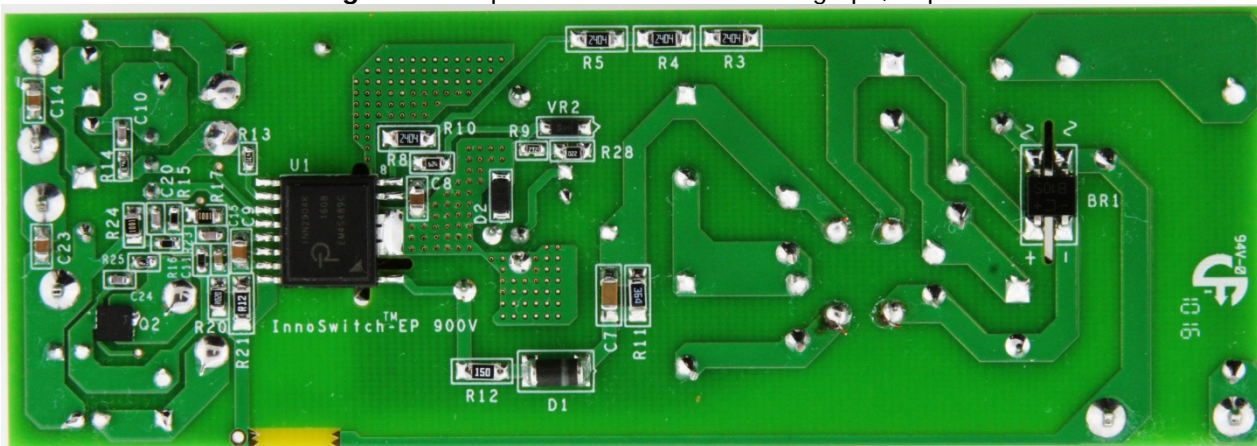


Figure 2 – Populated Circuit Board Photograph, Bottom.

2 Power Supply Specification

The table below represents the minimum acceptable performance of the design. Actual performance is listed in the results section.

| Description | Symbol | Min | Typ | Max | Units | Comment | |
|--------------------------------|---------------|-------------|-------|------|----------|--|--|
| Input | | | | | | | |
| Voltage | V_{IN} | 85 | | 484 | VAC | 2 Wire Input. | |
| Frequency | f_{LINE} | 47 | 50/60 | 64 | Hz | | |
| Output | | | | | | | |
| Output Voltage 1 | V_{OUT1} | 4.75 | 5 | 5.25 | V | ±5 %. | |
| Output Ripple Voltage 1 | $V_{RIPPLE1}$ | | | 50 | mV | 20 MHz Bandwidth. | |
| Output Current 1 | I_{OUT1} | 0 | | 0.5 | A | ±15 %, (±10 % with 0.1 A Min Load on 12 V.) 20 MHz Bandwidth. | |
| Output Voltage 2 | V_{OUT2} | 10.2 | 12 | 13.8 | V | | |
| Output Ripple Voltage 2 | $V_{RIPPLE2}$ | | | 150 | mV | | |
| Output Current 2 | I_{OUT2} | 0 | | 1.25 | A | | |
| Total Output Power | | | | | | | |
| Continuous Output Power | P_{OUT} | | 17.5 | | W | | |
| Efficiency | | | | | | | |
| Full Load | η | 86 | | | % | Measured at 110 / 230 VAC, P_{OUT} 25 °C. | |
| No-Load Input Power | | | | 280 | mW | V_{IN} at 230 VAC. | |
| Environmental | | | | | | | |
| Conducted EMI | | | | | | Meets CISPR22B / EN55022B | |
| Safety | | | | | | Designed to meet IEC950, UL1950 Class II | |
| Surge Differential | | 2 | | | kV | 1.2/50 μ s surge, IEC 1000-4-5, Series Impedance: Differential Mode: 2 Ω . | |
| Surge Common mode Ring Wave | | 6 | | | kV | 100 kHz Ring Wave, 12 Ω . Common Mode. | |
| ESD | | ±16.5 ±8 | | | kV kV | Air discharge Contact discharge No degradation in performance | |
| Ambient Temperature | T_{AMB} | 0 | | 40 | °C | Free Convection, Sea Level. | |

3 Schematic

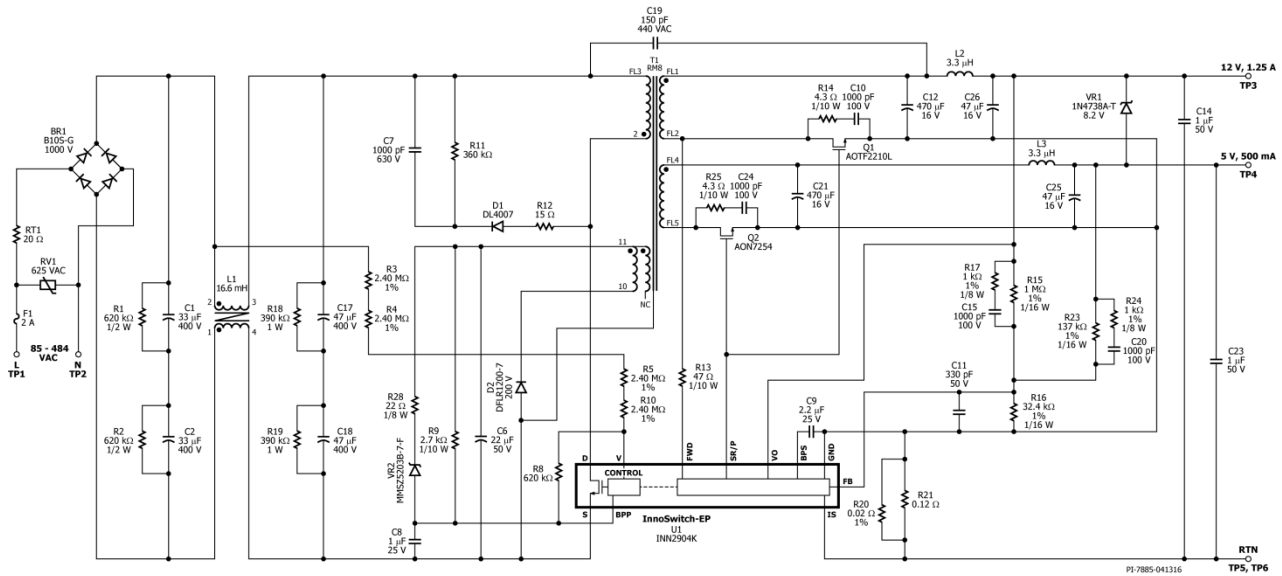


Figure 3 – Schematic.

4 Circuit Description

4.1 *Input EMI Filtering*

Fuse F1 isolates the circuit and provides protection from component failure and the common mode chokes L1 with capacitors, C1, C2, C17 and C18, provides attenuation for EMI. Bridge rectifier BR1 rectifies the AC line voltage and provides a full wave rectified DC across the filter consisting of C1 and C2. Thermistor RT1 is an inrush current limiter in the circuit with the high peak forward surge current rated bridge rectifier.

4.2 *InnoSwitch-EP Primary*

One side of the transformer primary is connected to the rectified DC bus, the other is connected to the integrated 900 V power MOSFET inside the InnoSwitch-EP IC (U1).

A low cost RCD clamp formed by D1, R11, R12, and C7 limits the peak drain voltage due to the effects of transformer leakage reactance and output trace inductance.

The IC is self-starting, using an internal high-voltage current source to charge the BPP pin capacitor, C8, when AC is first applied. During normal operation the primary side block is powered from an auxiliary winding on the transformer. The output of this is configured as a flyback winding which is rectified and filtered using diode D2 and capacitor C6, and fed in the BPP pin via a current limiting resistor R9. The primary side overvoltage protection is obtained using Zener diode VR2 and R28. In the event of overvoltage at output, the increased voltage at the output of the bias winding cause the Zener diode VR2 to conduct and triggers the OVP latch in the primary side controller of the InnoSwitch-EP IC.

Resistor R3, R4, R5, R10 and R8 provide line voltage sensing and provide a current to U1, which is proportional to the DC voltage across capacitors C1 and C2. At approximately 78 V DC, the current through these resistors exceeds the line under-voltage threshold, which results in enabling of U1. At approximately 700 V DC, the current through these resistors exceeds the line over-voltage threshold, which results in disabling of U1.

4.3 *InnoSwitch-EP Secondary*

The secondary side of the InnoSwitch-EP provides output voltage, output current sensing and drive to a MOSFET providing synchronous rectification.

Output rectification for the 5 V output is provided by SR FET Q2. Very low ESR capacitor C21 provides filtering, and inductor L3 and capacitor C25 form a second stage filter that significantly attenuates the high frequency ripple and noise at the 5 V output.

Output rectification for the 12 V output is provided by SR FET Q1. Very low ESR capacitors C12 provides filtering, and inductor L2 and capacitor C26 form a second stage

filter that significantly attenuates the high frequency ripple and noise at the 12 V output. C14 and C23 capacitors are used to high frequency switching ripple and radiated EMI.

RC snubber networks comprising R25 and C24 for Q2, R14 and C10 for Q1 damp high frequency ringing across SR FETs, which results from leakage inductance of the transformer windings and the secondary trace inductances.

In continuous conduction mode operation, the power MOSFET is turned off just prior to the secondary side controller commanding a new switching cycle from the primary. In discontinuous mode the MOSFET is turned off when the voltage drop across the MOSFET falls below a threshold ($V_{SR(TH)}$). Secondary side control of the primary side MOSFET ensure that it is never on simultaneously with the synchronous rectification MOSFET. The MOSFET drive signal is output on the SR/P pin.

The secondary side of the IC is self-powered from either the secondary winding forward voltage or the output voltage. The output voltage powers the device, fed into the V_O pin and charges the decoupling capacitor C9 via an internal regulator during CV region and forward secondary winding forward voltage powers the device during startup and CC region through R13. The unit enters auto-restart when the sensed output voltage is lower than 3 V.

Resistor R16, R15 and R23 form a voltage divider network that senses the output voltage from both outputs for better cross-regulation. Zener diode VR1 improves the cross regulation when only the 5 V output is loaded, which results in the 12 V output operating at the higher end of the specification. The InnoSwitch-EP IC has an internal reference of 1.265 V. Feedback compensation networks comprising capacitors C20, C15 and resistors R24, R17 reduce the output ripple voltage. Capacitor C11 provides decoupling from high frequency noise affecting power supply operation. Total output current is sensed by R20 and R21 with a threshold of approximately 33 mV to reduce losses. Once the current sense threshold across these resistors is exceeded, the device adjusts the number of switch pulses to maintain a fixed output current

5 PCB Layout

PCB copper thickness is 2 oz (2.8 mils / 70 μm) unless otherwise stated.

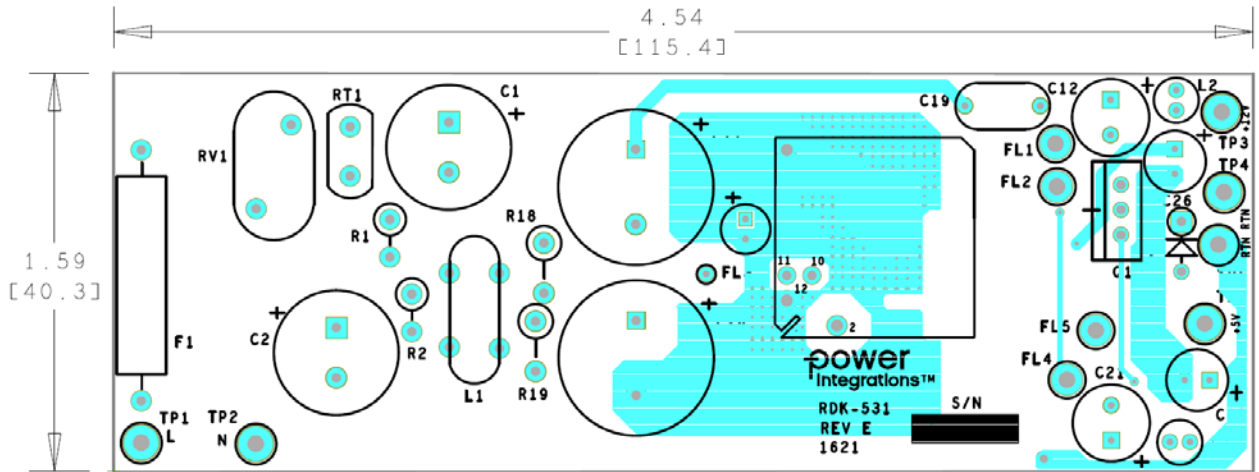


Figure 4 – Printed Circuit Layout, Top.

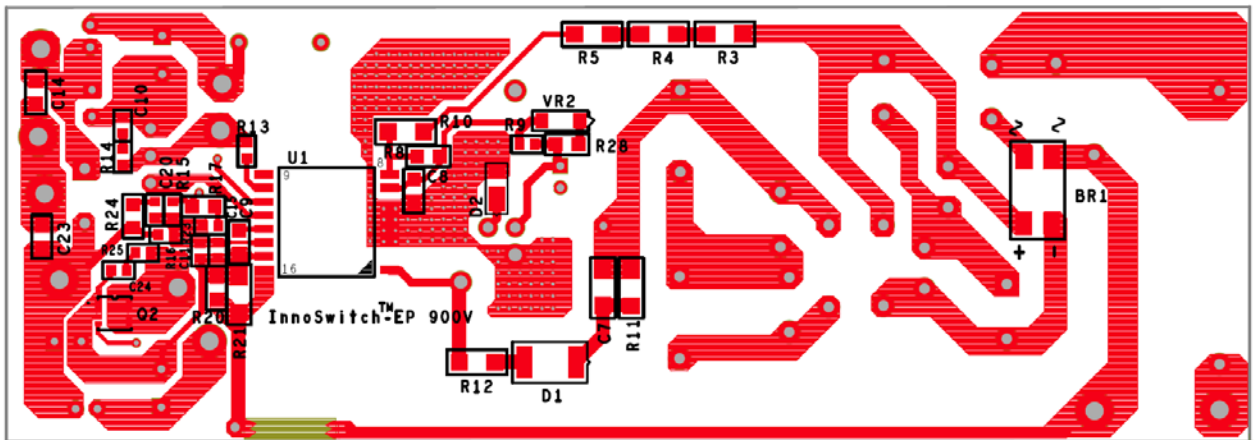


Figure 5 – Printed Circuit Layout, Bottom.

6 Bill of Materials

| Item | Qty | Ref Des | Description | Mfg Part Number | Mfg |
|------|-----|--------------------|--|-------------------------------------|--|
| 1 | 1 | BR1 | 1000 V, 0.8 A, Bridge Rectifier, SMD, MBS-1, 4-SOIC | B10S-G | Comchip |
| 2 | 2 | C1 C2 | 33 μ F, 400 V, Electrolytic, (12.5 x 20) | KMG401ELL330MK20S | Nippon Chemi-Con |
| 3 | 1 | C6 | 22 μ F, 50 V, Electrolytic, (5 x 11) | UPW1H220MDD | Nichicon |
| 4 | 1 | C7 | 1000 pF, 630 V, Ceramic, X7R, 1206 | C1206C102KBRCTU | Kemet |
| 5 | 1 | C8 | 1 μ F, 25 V, Ceramic, X5R, 0805 | C2012X5R1E105K | TDK |
| 6 | 1 | C9 | 2.2 μ F, 25 V, Ceramic, X7R, 0805 | C2012X7R1E225M | TDK |
| 7 | 4 | C10 C15 C20 C24 | 1000 pF, 100 V, Ceramic, NPO, 0603 | C1608C0G2A102J | TDK |
| 8 | 1 | C11 | 330 pF 50 V, Ceramic, X7R, 0603 | CC0603KRX7R9BB331 | Yageo |
| 9 | 2 | C12 C21 | 470 μ F, 16 V,Al Organic Polymer, 12 m Ω , (8 x 11.5) | RNE1C471MDN1 | Nichicon |
| 10 | 2 | C14 C23 | 1 μ F, 50 V, Ceramic, X7R, 0805 | C2012X7R1H105M | TDK Corp |
| 11 | 2 | C17 C18 | 47 μ F, 400 V, Electrolytic (16 x 20) | EKXJ401ELL470ML20S | United Chemi-Con |
| 12 | 1 | C19 | 150 pF, 440 Vac, Thru Hole, Ceramic Y-Capacitor | WKO151MPCPCFOKR | Vishay |
| 13 | 2 | C25 C26 | 47 μ F, 16 V, Electrolytic, Gen. Purpose, (6.3 x 7) | USA1C470MDD | Nichicon |
| 14 | 1 | D1 | 1000 V, 1 A, Rectifier, Glass Passivated, DO-213AA (MELF) | DL4007-13-F | Diodes, Inc. |
| 15 | 1 | D2 | 200 V, 1 A, Rectifier, Glass Passivated, POWERDI123 | DFLR1200-7 | Diodes, Inc. |
| 16 | 1 | F1 | FUSE, CERM, 2A, 500VAC, 400VDC, 5X20 | 0477002.MXEP | Littlefuse |
| 17 | 4 | FL1 FL2 FL4 FL5 | Flying Lead , Hole size 70mils | N/A | N/A |
| 18 | 1 | FL3 | Flying Lead , Hole size 30mils | N/A | N/A |
| 19 | 1 | L1 | 16.6 mH,xA, Ferite Toroid, 4 Pin, Output CMC Assembly CMC Assembly | SNX-R1840 TSD-3760 | Santronics Premier Magnetics |
| 20 | 2 | L2 L3 | 3.3 μ H, 1.5 A | 11R332C | Murata |
| 21 | 1 | Q1 | 200 V, 13 A, N-Channel, TO-220 | AOTF2210L | Alpha & Omega |
| 22 | 1 | Q2 | 150 V, 17A N-Channel, 8DFN | AON7254 | Alpha & Omega |
| 23 | 2 | R1 R2 | RES, 620 k, 5%, 1/2 W, Carbon Film | CFR-50JB-620K | Yageo |
| 24 | 4 | R3 R4 R5 R10 | RES, 2.4 M, 1%, 1/4 W, Thick Film, 1206 | RC1206FR-072M4L | Yageo |
| 25 | 1 | R8 | RES, 620 k Ω , 5%, 1/8 W, Thick Film, 0805 | ERJ-6GEYJ624V | Panasonic |
| 26 | 1 | R9 | RES, 2.7 k Ω , 5%, 1/10 W, Thick Film, 0603 | ERJ-3GEYJ272V | Panasonic |
| 27 | 1 | R11 | RES, 360 k Ω , 5%, 1/4 W, Thick Film, 1206 | ERJ-8GEYJ364V | Panasonic |
| 28 | 1 | R12 | RES, 15 Ω , 5%, 1/4 W, Thick Film, 1206 | ERJ-8GEYJ150V | Panasonic |
| 29 | 1 | R13 | RES, 47 Ω , 5%, 1/10 W, Thick Film, 0603 | ERJ-3GEYJ470V | Panasonic |
| 30 | 2 | R14 R25 | RES, 4.3 Ω , 5%, 1/10 W, Thick Film, 0603 | ERJ-3GEYJ4R3V | Panasonic |
| 31 | 1 | R15 | RES, 1.00 M Ω , 1%, 1/16 W, Thick Film, 0603 | ERJ-3EKF1004V | Panasonic |
| 32 | 1 | R16 | RES, 32.4 k Ω , 1%, 1/16 W, Thick Film, 0603 | ERJ-3EKF3242V | Panasonic |
| 33 | 2 | R17 R24 | RES, 1.00 k Ω , 1%, 1/8 W, Thick Film, 0805 | ERJ-6ENF1001V | Panasonic |
| 34 | 2 | R18 R19 | RES, 390 k Ω , 5%, 1 W, Metal Oxide | RSF100JB-390K | Yageo |
| 35 | 1 | R20 | RES, 0.02 Ω , 1%, 1/4 W, Thick Film, 0805 | RL0805FR-7WOR02L | Yageo |
| 36 | 1 | R21 | RES, 0.12 Ω , 5%, 1/4 W, Thick Film, 1206 | ERJ-8RSJR12V | Panasonic |
| 37 | 1 | R23 | RES, 137 k Ω , 1%, 1/16 W, Thick Film, 0603 | ERJ-3EKF1373V | Panasonic |
| 38 | 1 | R28 | RES, 22 Ω , 5%, 1/8 W, Thick Film, 0805 | ERJ-6GEYJ220V | Panasonic |
| 39 | 1 | RT1 | NTC Thermistor, 20 Ω , 0.3 A | 20D2-05LD | Semitec |
| 40 | 1 | RV1 | 625 V,100 J, 14 mm, RADIAL | ERZ-V14D102 | Panasonic |
| 41 | 1 | T1 | Bobbin, RM8, Vertical, 12 pins Transformer Assembly Transformer Assembly | RM8/12/1 SNX-R1839 POL-INNO14 | Schwartzpunkt Santronics Premier Magnetics |
| 42 | 1 | TP1 | Test Point, WHT, THRU-HOLE MOUNT | 5012 | Keystone |
| 43 | 3 | TP2 TP4 TP6 | Test Point, BLK, THRU-HOLE MOUNT | 5011 | Keystone |
| 44 | 2 | TP3 TP5 | Test Point, RED, THRU-HOLE MOUNT | 5010 | Keystone |



| | | | | | |
|----|---|-----|--|---------------|--------------------|
| 45 | 1 | U1 | InnoSwitch-EP, Off-Line CV/CC Flyback Switcher | INN2904K | Power Integrations |
| 46 | 1 | VR1 | 8.2 V, 5%, 1 W, DO-41 | 1N4738A,113 | NXP Semi |
| 47 | 1 | VR2 | DIODE ZENER 4.7V 500MW SOD123 | MMSZ5230B-7-F | Diodes, Inc. |



7 Transformer (T1) Specification

7.1 Transformer Electrical Diagram

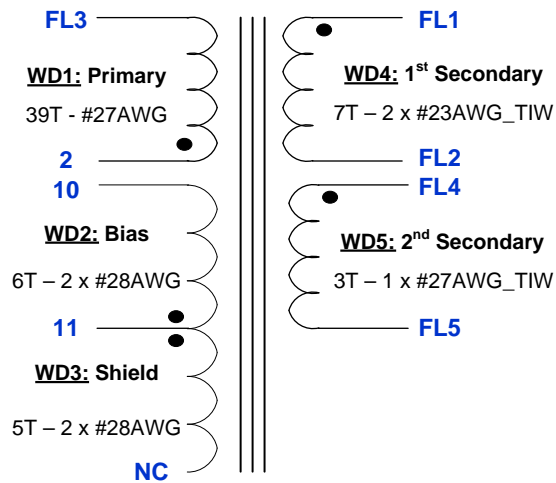


Figure 6 – Transformer Electrical Diagram.

7.2 Electrical Specifications

| Parameter | Condition | Spec. |
|-----------------------------------|--|-----------------------|
| Nominal Primary Inductance | Measured at 1 V _{PK-PK} , 100 kHz switching frequency, between pin 2 and FL3, with all other windings open. | 381 μ H \pm 10% |
| Resonant Frequency | Between pin 2 and FL3, other windings open. | 1100 kHz (Min.) |
| Primary Leakage Inductance | Between pin 2 and FL3, with FL1, FL2, FL4, FL5 shorted. | 10 μ H (Max). |

7.3 Material List

| Item | Description |
|------|--|
| [1] | Core: RM8, PC95 TDK or DMR95 from DMEGC magnetics. |
| [2] | Bobbin: RM8, Vertical, 12 pins (6/6-circular) (PI P/N: 25-01084-00). |
| [3] | Core Clip: Allstar Magnetic, P/N: CLI/P-RM8/I. |
| [4] | Magnet Wire: #27 AWG, double coated. |
| [5] | Magnet Wire: #28 AWG, double coated. |
| [6] | Magnet Wire: #23 AWG, Triple Insulated Wire. |
| [7] | Magnet Wire: #27 AWG, Triple Insulated Wire. |
| [8] | Barrier Tape: 3M 1298 Polyester Film, 1 mil thickness, 9.5 mm wide. |
| [9] | Varnish: Dolph BC-359. |

7.4 Transformer Build Diagram

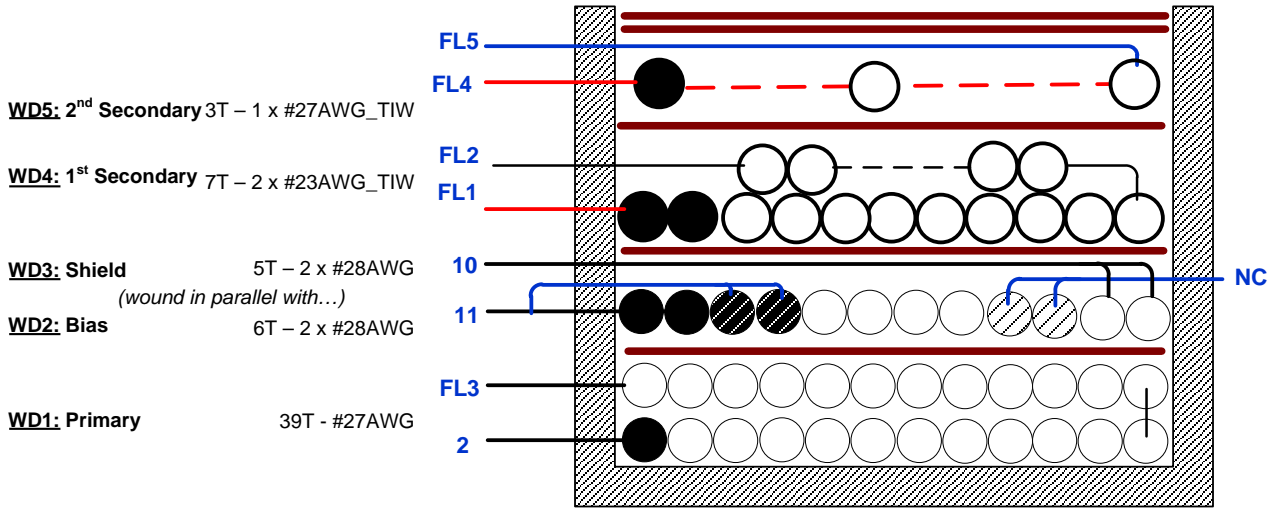


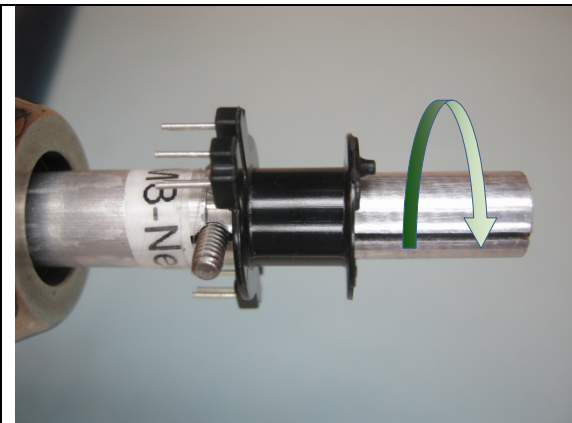
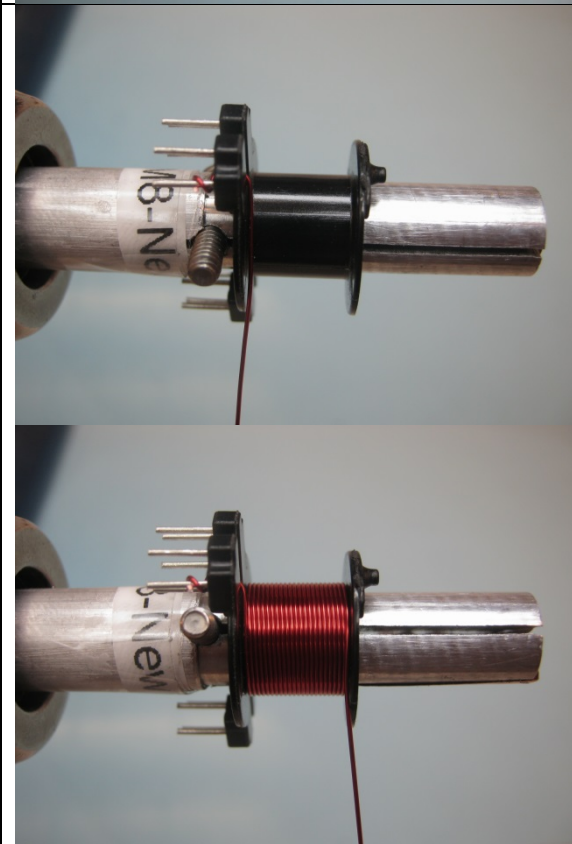
Figure 7 – Transformer Build Diagram.

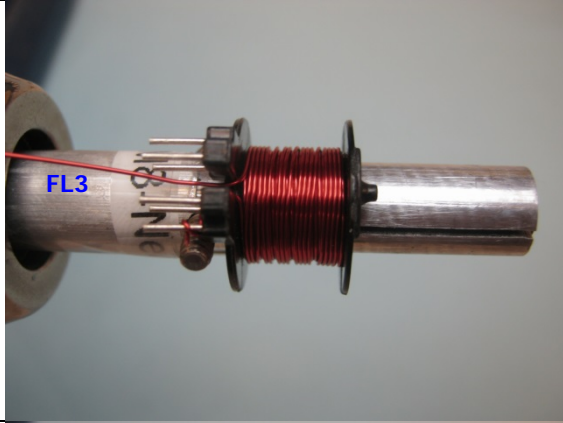
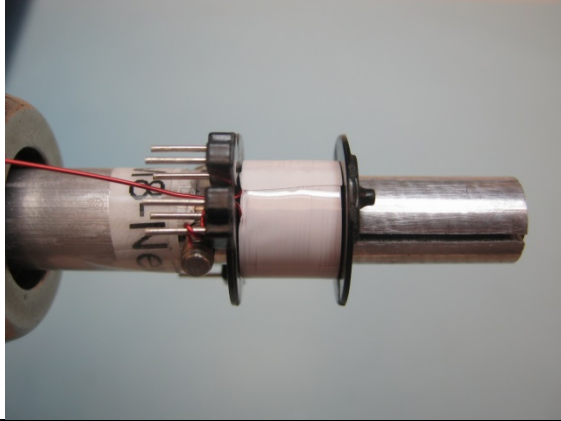
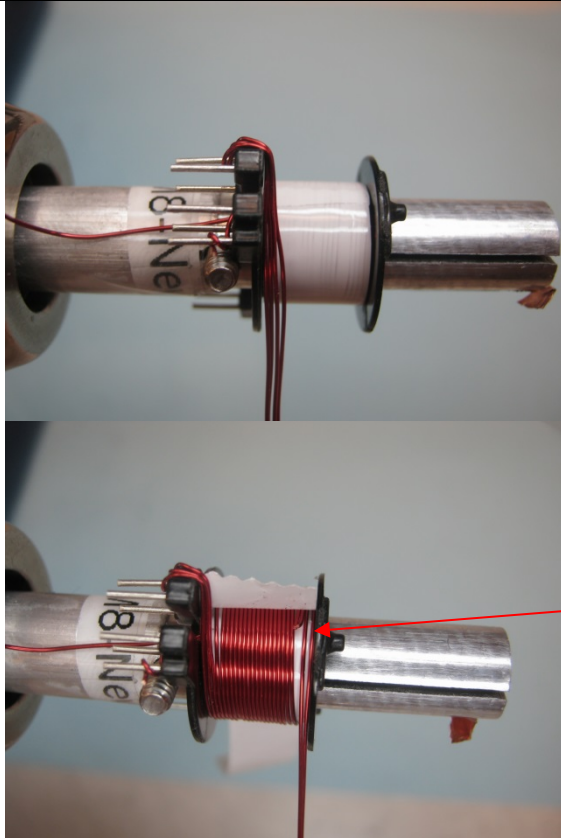
7.5 Transformer construction

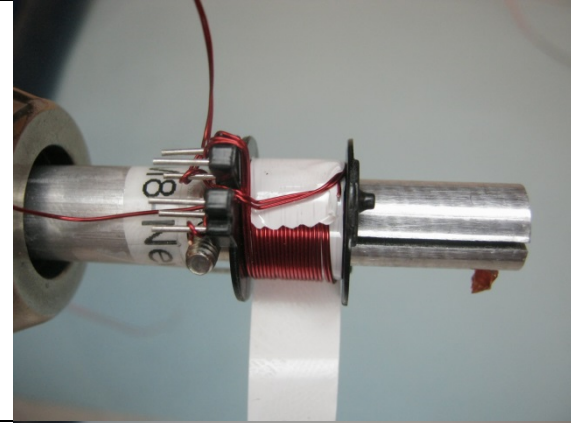
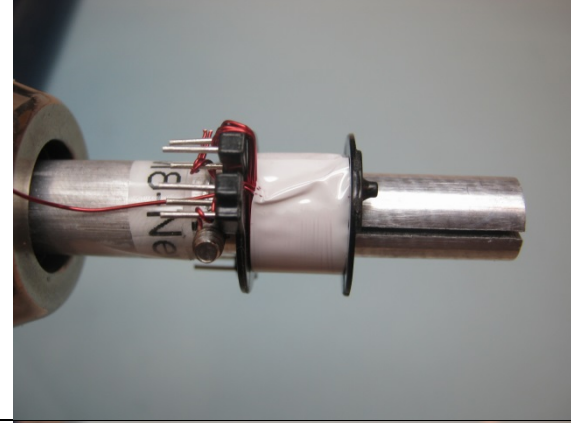
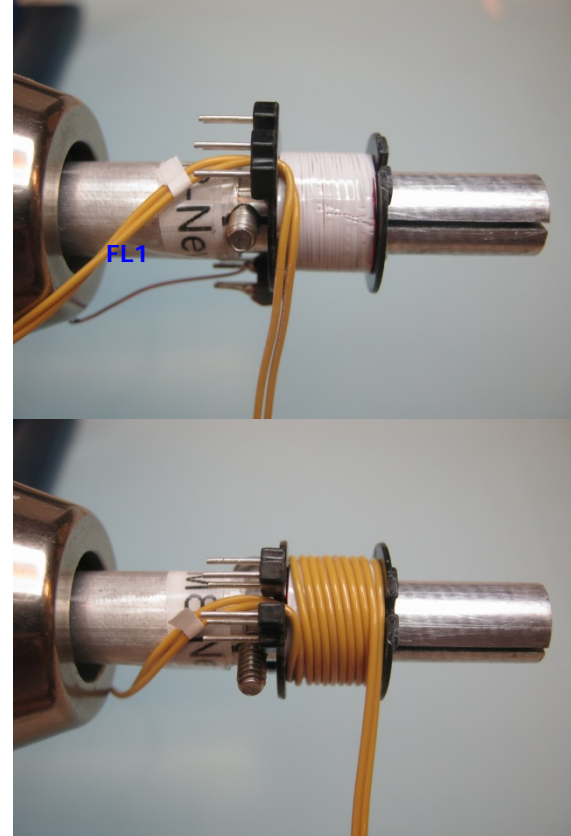
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|--|--|
| Winding Preparation | Position the bobbin item [2] on the mandrel such that the pin side of the bobbin is on the left side. Winding direction is clock-wise direction. |
| WD1 Primary | Start at pin 2, wind 39 turns of wire item [4] in 2 layers, with tight tension, spread wire evenly for 2 nd layer. At the last turn leave ~1" floating and mark as FL3. |
| Insulation | 1 layer of tape item [8]. |
| WD2 & WD3 Bias & Shield | Start at pin 11, use 4 wires item [5], wind 5 turns, cut 2 wires as No-Connect for WD3. Continue winding other 2 wires 1 more turn and finish at pin 10 for WD2. |
| Insulation | 1 layer of tape item [8]. |
| WD4 1st Secondary | Use 2 wires item [6], leave ~1" floating for start leads FL1, wind 7 turns in 1 ½ layers and finish with ~1" floating for end leads FL2. |
| Insulation | 1 layer of tape item [8]. |
| WD5 2nd Secondary | Use single wire item [7], leave ~1" floating for start lead FL4, wind 3 turns in 1 layer, spread wire evenly across the bobbin, and finish with ~1" floating for end lead FL5. |
| Insulation | 2 layers of tape item [8] for insulation and secure the windings. |
| Finish | Gap cores to get 381 μH, assemble cores with tape. Varnish with item [9]. |



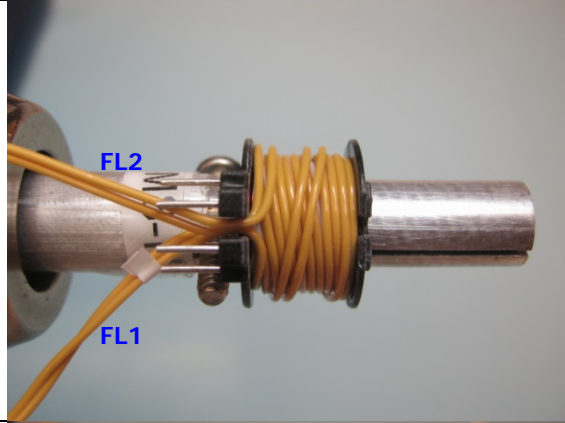
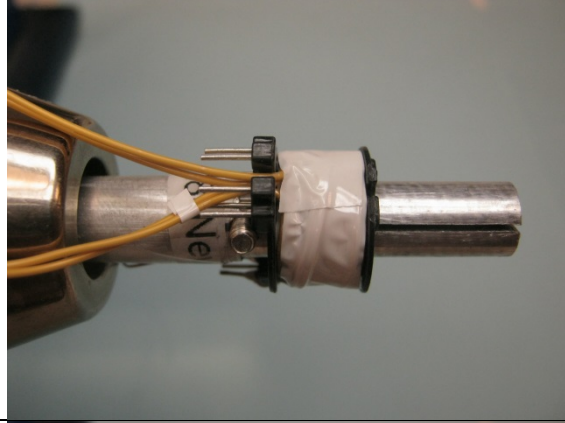
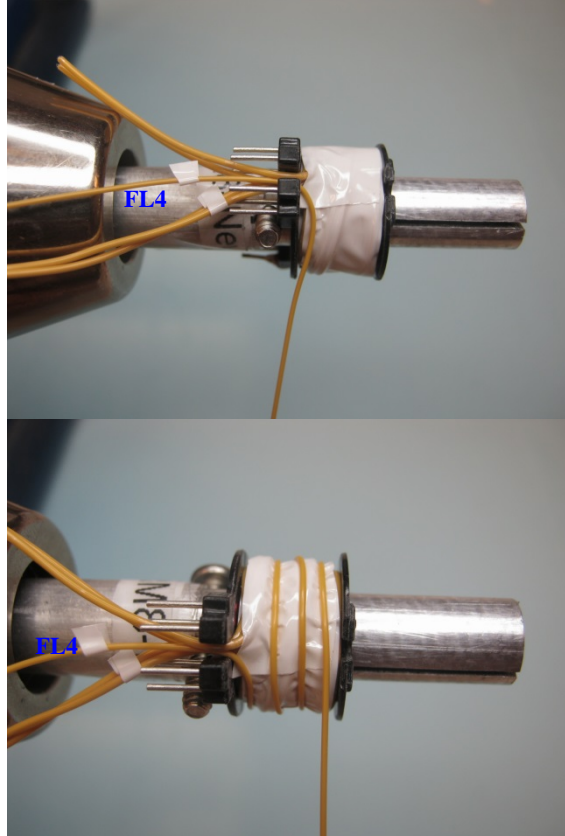
7.6 *Winding Illustrations*

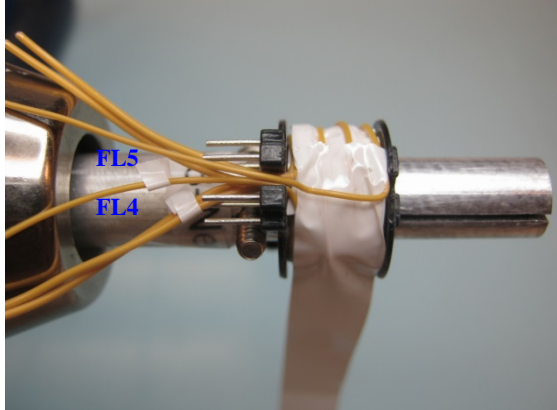
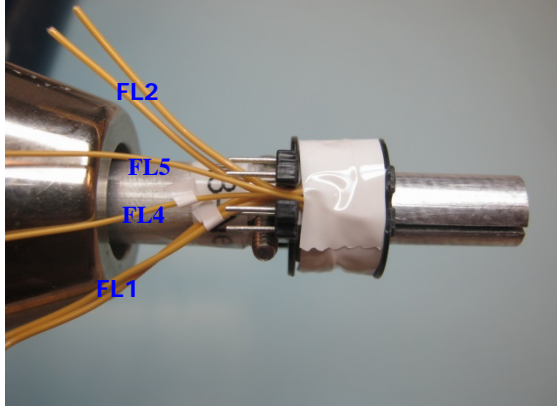
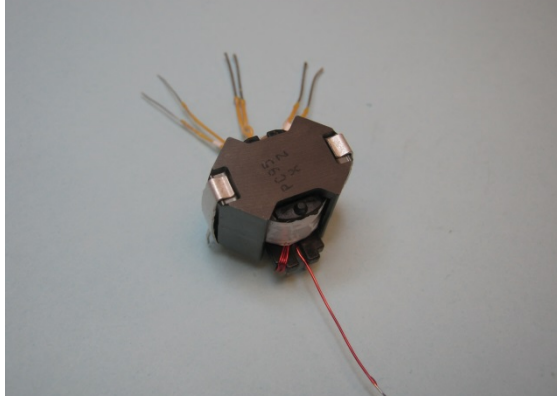
| | | |
|-----------------------------------|---|--|
| <p>Winding Preparation</p> |  | <p>Position the bobbin item [2] on the mandrel such that the pin side of the bobbin is on the left side. Winding direction is clockwise direction.</p> |
| <p>WD1 Primary</p> |  | <p>Start at pin 2, wind 39 turns of wire item [4] in 2 layers, with tight tension, spread wire evenly for 2nd layer. At the last turn leave ~1" floating and mark as FL3.</p> |

| | | |
|---|--|--|
| |  | |
| <p>Insulation</p> |  | <p>1 layer of tape item [8].</p> |
| <p>WD2 & WD3 Bias & Shield</p> |  | <p>Start at pin 11, use 4 wires item [5], wind 5 turns, cut <u>2 wires as No-Connect</u> for WD3. Continue winding other 2 wires 1 more turn and finish at pin 10 for WD2.</p> |

| | | |
|--|--|---|
| |  | |
| <p>Insulation</p> |  | <p>1 layer of tape item [8].</p> |
| <p>WD4 1st Secondary</p> |  | <p>Use 2 wires item [6], leave ~1" floating for start leads FL1, wind 7 turns in 1 1/2 layers and finish with ~1" floating for end leads FL2.</p> |



| | | |
|--|--|---|
| |  | |
| <p>Insulation</p> |  | <p>1 layer of tape item [8].</p> |
| <p>WD5 2nd Secondary</p> |  | <p>Use single wire item [7], leave ~1" floating for start lead FL4, wind 3 turns in 1 layer, spread wire evenly across the bobbin, and finish with ~1" floating for end lead FL5.</p> |

| | | |
|--------------------------|--|---|
| |  | |
| <p>Insulation</p> |  | <p>2 layers of tape item [8] for insulation and secure the windings.</p> |
| <p>Finish</p> |  | <p>Gap cores to get 381 μH, assemble cores with tape. Varnish with item [9].</p> |

8 Common Mode Choke (L1) Specification

8.1 Electrical Diagram

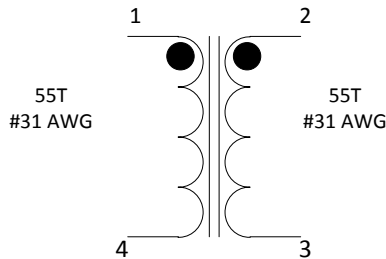


Figure 8 – Inductor Electrical Diagram.

8.2 Electrical Specifications

| | | |
|-----------------------------------|---|------------------------|
| Inductance | Pins 1-4 and pins 2-3 measured at 100 kHz, 0.4 RMS. | 16.6 mH ±25% |
| Core Effective Inductance | | 5500 nH/N ² |
| Primary Leakage Inductance | Pins 1-4, with 2-3 shorted. | 80 μH |

8.3 Material List

| Item | Description |
|------|---|
| [1] | Toroid: FERRITE INDUCTR TOROID. 1) JLW Electronics (Hong Kong), T14 x 8 x 5.5C-JL10. 2) TDK, B64290L0658 x 038 material. 3) PI Part number: #32-00286-00 |
| | Divider: Cable-tie, Panduit, PLT.7M-M. |
| [2] | Magnet Wire: #31 AWG Heavy Nyleze. |

8.4 Winding Instructions

- 1) Place 2 pieces of cable tie item [2] onto toroid item [1] to divide 2 equal sections.
- 2) Use 4 ft of wire item [3], start as pin 1 wind 55 turns in 2 layers in 1 section of toroid, and end at pin 4.
- 3) Do the same for another section of toroid, start at pin 2 then end at pin 3 symmetrically with last winding.
- 4) Use hot glue or Epoxy to hold the windings in place.

8.5 Illustrations

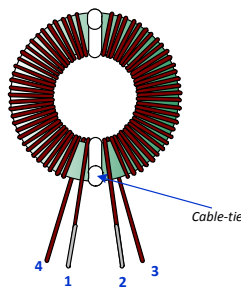


Figure 9 – Inductor Illustration.

9 Transformer Design Spreadsheet

| ACDC_InnoSwitch-EP_052115; Rev.0.1; Copyright Power Integrations 2015 | INPUT | INFO | OUTPUT | UNIT | ACDC_InnoSwitch-EP_051915_Rev0-1; InnoSwitch-EP Continuous/Discontinuous Flyback Transformer Design Spreadsheet |
|---|---------|------|-------------------------|--------------------|---|
| ENTER APPLICATION VARIABLES | | | | | |
| VACMIN | 85 | | 85 | V | Minimum AC Input Voltage |
| VACMAX | 484 | | 484 | V | Maximum AC Input Voltage |
| fL | | | 50 | Hz | AC Mains Frequency |
| VO | 5.00 | | 5.00 | V | Output Voltage (continuous power at the end of the cable) |
| IO | 3.50 | | 3.50 | A | Power Supply Output Current (corresponding to peak power) |
| Power | | | 17.50 | W | Continuous Output Power, including cable drop compensation |
| n | 0.82 | | 0.82 | | Efficiency Estimate at output terminals. Use 0.8 if no better data available |
| Z | 0.40 | | 0.40 | | Z Factor. Ratio of secondary side losses to the total losses in the power supply. Use 0.5 if no better data available |
| tC | | | 3.00 | mSeconds | Bridge Rectifier Conduction Time Estimate |
| CIN | 36.00 | | 36.00 | uFarad | Input Capacitance |
| ENTER InnoSwitch-EP VARIABLES | | | | | |
| InnoSwitch-EP | INN2904 | | INN2904 | | User defined InnoSwitch |
| Chose Configuration | INC | | Increased Current Limit | | Enter "RED" for reduced current limit (sealed adapters), "STD" for standard current limit or "INC" for increased current limit (peak or higher power applications) |
| ILIMITMIN | | | 1.070 | A | Minimum Current Limit |
| ILIMITTYP | | | 1.150 | A | Typical Current Limit |
| ILIMITMAX | | | 1.231 | A | Maximum Current Limit |
| fSmin | | | 93000 | Hz | Minimum Device Switching Frequency |
| I ² fmin | | | 111.09 | A ² kHz | Worst case I ² F parameter across the temperature range |
| VOR | 67 | | 67 | V | Reflected Output Voltage (VOR <= 100 V Recommended) |
| VDS | | | 5.00 | V | InnoSwitch on-state Drain to Source Voltage |
| KP | | | 0.981 | | Ripple to Peak Current Ratio at Vmin, assuming ILIMITMIN, and I2FMIN (KP < 6) |
| KP_TRANSIENT | | | 0.483 | | Worst case transient Ripple to Peak Current Ratio. Ensure KP_TRANSIENT > 0.25 |
| ENTER InnoSwitch-EP PROTECTION VARIABLES | | | | | |
| Line Undervoltage | | | | | |
| BROWN IN | | | 67.0 | VRMS | Minimum RMS AC Voltage at which the power supply will BROWN-IN (turn-on). The actual value of this voltage may differ slightly from the desired value due to the V-pin resistor's tolerance |
| BROWN OUT | | | 54.9 | VRMS | Typical RMS AC Voltage at which the power supply will BROWN-OUT (turn-off) under conditions of line-undervoltage |
| RLS | | | 7.32 | MOhms | Theoretical V-pin resistor for the desired UV/OV setup |
| RLS1/RLS2 | | | 3.65 | MOhms | Use two 1% resistors in series for line sense (V-Pin) functionality |
| VBROWNIN VARIATION | | | 0.00 | % | Variation between the actual and desired brown-in voltage |
| Line Overvoltage | | | | | |
| BROWN IN | | | 275.9 | VRMS | Typical RMS AC voltage at which the power supply will BROWN-IN (turn-on) after a line overvoltage BROWN-OUT (turn-off) event |



| | | | | | |
|--|-----|---------|--------------|-------------------|--|
| BROWN OUT | | | 290.4 | VRMS | Typical RMS AC voltage at which the power supply will BROWN-OUT (turn-off) under conditions of line-overvoltage |
| Load Overcurrent | | | | | |
| IOMAX | | | 2.10 | A | Load current beyond which the device will enter into overload protection. By default value consists of the sum of all output currents multiplied by 1.2 |
| RIS | | | 0.017 | Ohms | Use a 0.017 Ohm, 1-5% resistor having a minimum power rating of 0.0735W on the IS pin for load overcurrent protection |
| ENTER BIAS WINDING VARIABLES | | | | | |
| VB | | | 10.00 | V | Bias Winding Voltage |
| VDB | | | 0.70 | V | Bias Winding Diode Forward Voltage Drop |
| NB | | | 5.89 | V | Bias Winding Number of Turns |
| PIVB | | | 156.60 | V | Bias winding peak reverse voltage at VACmax and assuming VB*1.2 |
| ENTER TRANSFORMER CORE/CONSTRUCTION VARIABLES | | | | | |
| Core Type | RM8 | | RM8 | | Enter Transformer Core |
| Core | | | PC47RM8Z-12 | | Enter core part number, if necessary |
| Bobbin | | | BRM8-718CPFR | | Enter bobbin part number, if necessary |
| AE | | | 0.64 | cm ² | Core Effective Cross Sectional Area |
| LE | | | 3.80 | cm | Core Effective Path Length |
| AL | | | 1950 | nH/T ² | Ungapped Core Effective Inductance |
| BW | | | 9.05 | mm | Bobbin Physical Winding Width |
| M | | | 0.00 | mm | Safety Margin Width (Half the Primary to Secondary Creepage Distance) |
| L | 2 | | 2 | | Number of Primary Layers |
| NS | | | 3 | | Number of Secondary Turns |
| DC INPUT VOLTAGE PARAMETERS | | | | | |
| VMIN | | | 78 | V | Minimum DC Input Voltage |
| VMAX | | | 684 | V | Maximum DC Input Voltage |
| CURRENT WAVEFORM SHAPE PARAMETERS | | | | | |
| DMAX | | | 0.48 | | Duty Ratio at full load, minimum primary inductance and minimum input voltage |
| IAVG | | | 0.26 | A | Average Primary Current |
| IP | | | 1.07 | A | Peak Primary Current assuming ILIMITMIN |
| IR | | | 1.05 | A | Primary Ripple Current assuming ILIMITMIN, and LPMIN |
| IRMS | | | 0.43 | A | Primary RMS Current, assuming ILIMITMIN, and LPMIN |
| TRANSFORMER PRIMARY DESIGN PARAMETERS | | | | | |
| LP | | Warning | 381 | uHenry | !!! Low primary inductance (LP), Excessive di/dt. Peak drain current may exceed maximum rating. Design for higher output power, or reduce current limit and/or device size |
| LP_TOLERANCE | 10 | | 10 | % | Primary inductance tolerance |
| NP | | | 39 | | Primary Winding Number of Turns |
| ALG | | | 250 | nH/T ² | Gapped Core Effective Inductance |
| BM | | | 2649 | Gauss | Maximum Operating Flux Density, BM<3000 is recommended |
| BAC | | | 1299 | Gauss | AC Flux Density for Core Loss Curves (0.5 X Peak to Peak) |
| ur | | | 921 | | Relative Permeability of Ungapped Core |
| LG | | | 0.28 | mm | Gap Length (Lg > 0.1 mm) |
| BWE | | | 18.1 | mm | Effective Bobbin Width |
| OD | | | 0.464 | mm | Maximum Primary Wire Diameter including insulation |
| INS | | | 0.064 | mm | Estimated Total Insulation Thickness (= 2 * film thickness) |

| | | | | | |
|--|-------|----------------|---------------|-----------|--|
| DIA | | | 0.401 | mm | Bare conductor diameter |
| AWG | | | 27 | AWG | Primary Wire Gauge (Rounded to next smaller standard AWG value) |
| CM | | | 203 | Cmils | Bare conductor effective area in circular mils |
| CMA | | | 473 | Cmils/Amp | Primary Winding Current Capacity (200 < CMA < 500) |
| TRANSFORMER SECONDARY DESIGN PARAMETERS | | | | | |
| Lumped parameters | | | | | |
| ISP | | | 13.90 | A | Peak Secondary Current, assuming I _{LIMITMIN} |
| ISRMS | | | 5.87 | A | Secondary RMS Current |
| IRIPPLE | | | 4.71 | A | Output Capacitor RMS Ripple Current |
| CMS | | | 1174 | Cmils | Secondary Bare Conductor minimum circular mils |
| AWGS | | | 19 | AWG | Secondary Wire Gauge (Rounded up to next larger standard AWG value) |
| VOLTAGE STRESS PARAMETERS | | | | | |
| VDRAIN | | Warning | 844 | V | !!! REDUCE DRAIN VOLTAGE V _{drain} <680 Volts. Reduce VOR or Reduce VACMAX |
| PIVS | | | 79 | V | Output Rectifier Maximum Peak Inverse Voltage for 1st output, assuming the primary has a Voltage spike 40% above V _{MAX} and V _O *1.05 |
| TRANSFORMER SECONDARY DESIGN PARAMETERS | | | | | |
| 1st output | | | | | |
| VO1 | | | 5.00 | V | Main Output Voltage directly after output rectifier |
| IO1 | 0.50 | | 0.50 | A | Output DC Current |
| PO1 | | | 2.50 | W | Output Power |
| VD1 | | | 0.10 | V | Output Synchronous Rectification FET Forward Voltage Drop |
| NS1 | | | 3.00 | Turns | Output Winding Number of Turns |
| ISRMS1 | | | 0.84 | A | Output Winding RMS Current |
| IRIPPLE1 | | | 0.67 | A | Output Capacitor RMS Ripple Current |
| PIVS1 | | | 79 | V | Output Rectifier Maximum Peak Inverse Voltage, assuming the primary has a Voltage spike 40% above V _{MAX} and V _O *1.05 |
| CMS1 | | | 168 | Cmils | Output Winding Bare Conductor minimum circular mils |
| AWGS1 | | | 27 | AWG | Wire Gauge (Rounded up to next larger standard AWG value) |
| DIAS1 | | | 0.36 | mm | Minimum Bare Conductor Diameter |
| ODS1 | | | 3.02 | mm | Maximum Outside Diameter for Triple Insulated Wire |
| Recommended MOSFET | | | Si7456 | | Recommended SR FET for this output |
| RDSON_HOT | | | 0.042 | Ohm | RDSon at 100C |
| VRATED | | | 100 | V | Rated voltage of selected SR FET |
| 2nd output | | | | | |
| VO2 | 12.00 | | 12.00 | V | Output Voltage |
| IO2 | 1.25 | | 1.25 | A | Output DC Current |
| PO2 | | | 15.00 | W | Output Power |
| VD2 | | | 0.70 | V | Output Diode Forward Voltage Drop |
| NS2 | | | 7 | | Output Winding Number of Turns |
| ISRMS2 | | | 2.10 | A | Output Winding RMS Current |
| IRIPPLE2 | | | 1.68 | A | Output Capacitor RMS Ripple Current |
| PIVS2 | | | 185 | V | Output Rectifier Maximum Peak Inverse Voltage |
| CMS2 | | | 419 | Cmils | Output Winding Bare Conductor minimum circular mils |
| AWGS2 | | | 23 | AWG | Wire Gauge (Rounded up to next larger standard AWG value) |
| DIAS2 | | | 0.58 | mm | Minimum Bare Conductor Diameter |
| ODS2 | | | 1.29 | mm | Maximum Outside Diameter for Triple Insulated Wire |
| 3rd output | | | | | |



| | | | | | |
|--------------------|--|--|-------|-------|---|
| VO3 | | | 0.00 | V | Output Voltage |
| IO3 | | | 0.00 | A | Output DC Current |
| PO3 | | | 0.00 | W | Output Power |
| VD3 | | | 0.70 | V | Output Diode Forward Voltage Drop |
| NS3 | | | 0 | | Output Winding Number of Turns |
| ISRMS3 | | | 0.00 | A | Output Winding RMS Current |
| IRIPPLE3 | | | 0.00 | A | Output Capacitor RMS Ripple Current |
| PIVS3 | | | 0 | V | Output Rectifier Maximum Peak Inverse Voltage |
| CMS3 | | | 0 | Cmils | Output Winding Bare Conductor minimum circular mils |
| AWGS3 | | | N/A | AWG | Wire Gauge (Rounded up to next larger standard AWG value) |
| DIAS3 | | | N/A | mm | Minimum Bare Conductor Diameter |
| ODS3 | | | N/A | mm | Maximum Outside Diameter for Triple Insulated Wire |
| Total power | | | 17.50 | W | Total Power for Multi-output section |
| Negative Output | | | N/A | | If negative output exists enter Output number; e.g. If VO2 is negative output, select 2 |

10 Performance Data

10.1 Full Load Efficiency vs. Line

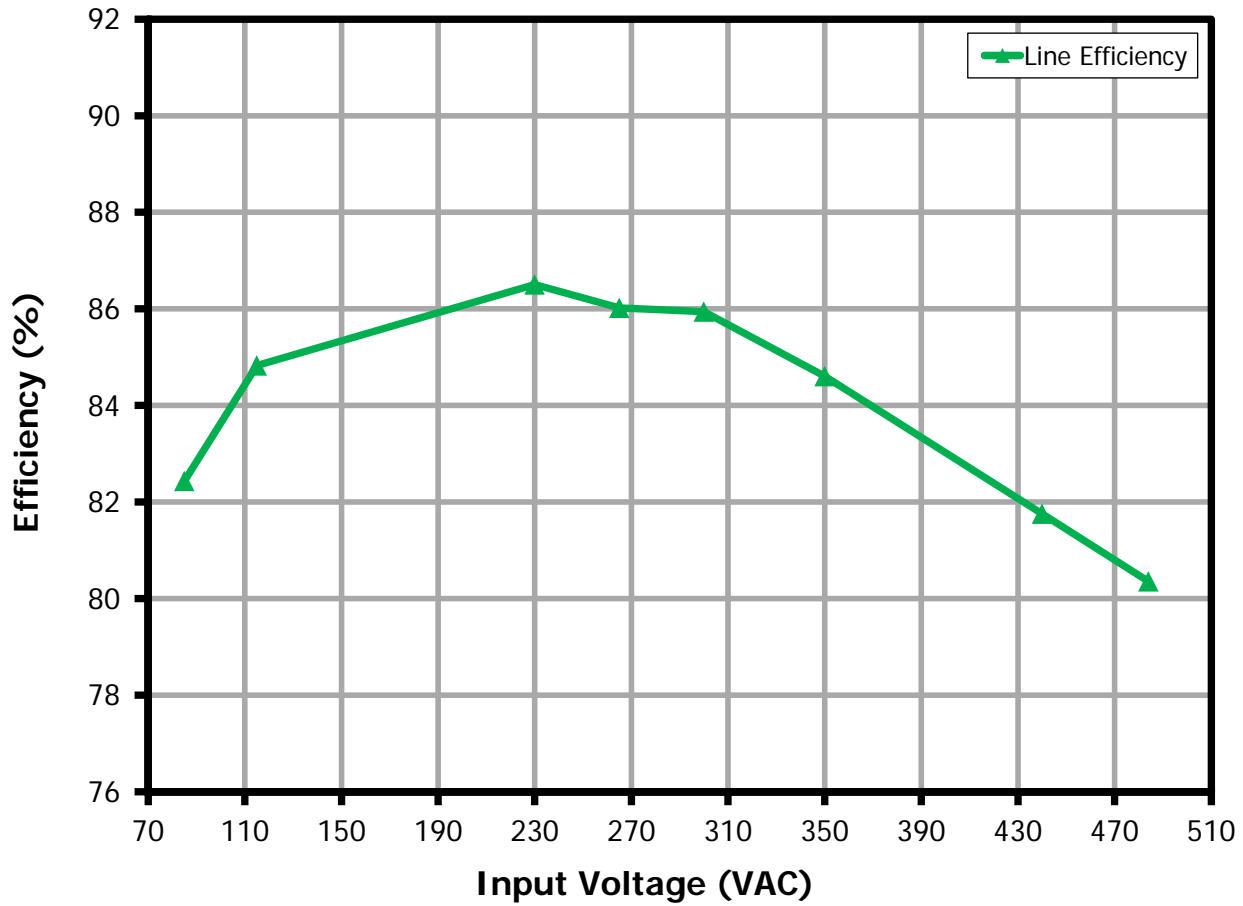


Figure 10 – Full load Efficiency vs. Line Voltage, Room Temperature.

10.2 *No-Load Input Power*

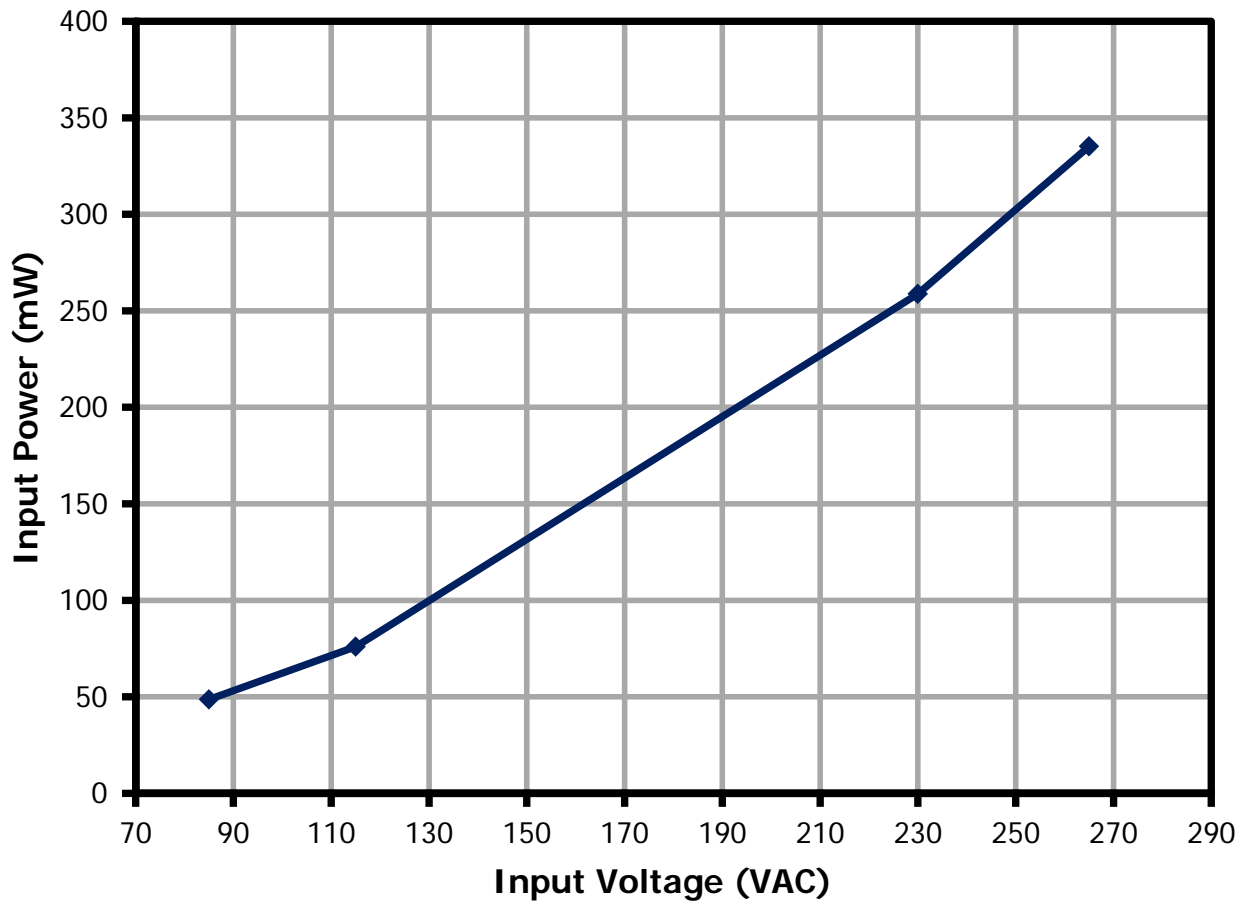


Figure 11 – No-Load Input Power vs. Input Line Voltage, Room Temperature.



10.3 Line and Load Regulation

10.3.1 Line Regulation (Full Load)

| VAC | V _{OUT} (12 V) | I _{OUT} (12 V) | V _{OUT} (5V) | I _{OUT} (5 V) |
|-----|-------------------------|-------------------------|-----------------------|------------------------|
| 85 | 12.05 | 1.243 | 5.08 | 0.502 |
| 115 | 12.04 | 1.243 | 5.09 | 0.502 |
| 230 | 12.04 | 1.243 | 5.1 | 0.502 |
| 265 | 12.03 | 1.243 | 5.1 | 0.5 |
| 300 | 12.04 | 1.243 | 5.11 | 0.5 |
| 350 | 12.05 | 1.243 | 5.11 | 0.5 |
| 440 | 12.02 | 1.243 | 5.1 | 0.5 |
| 484 | 12.04 | 1.243 | 5.11 | 0.5 |

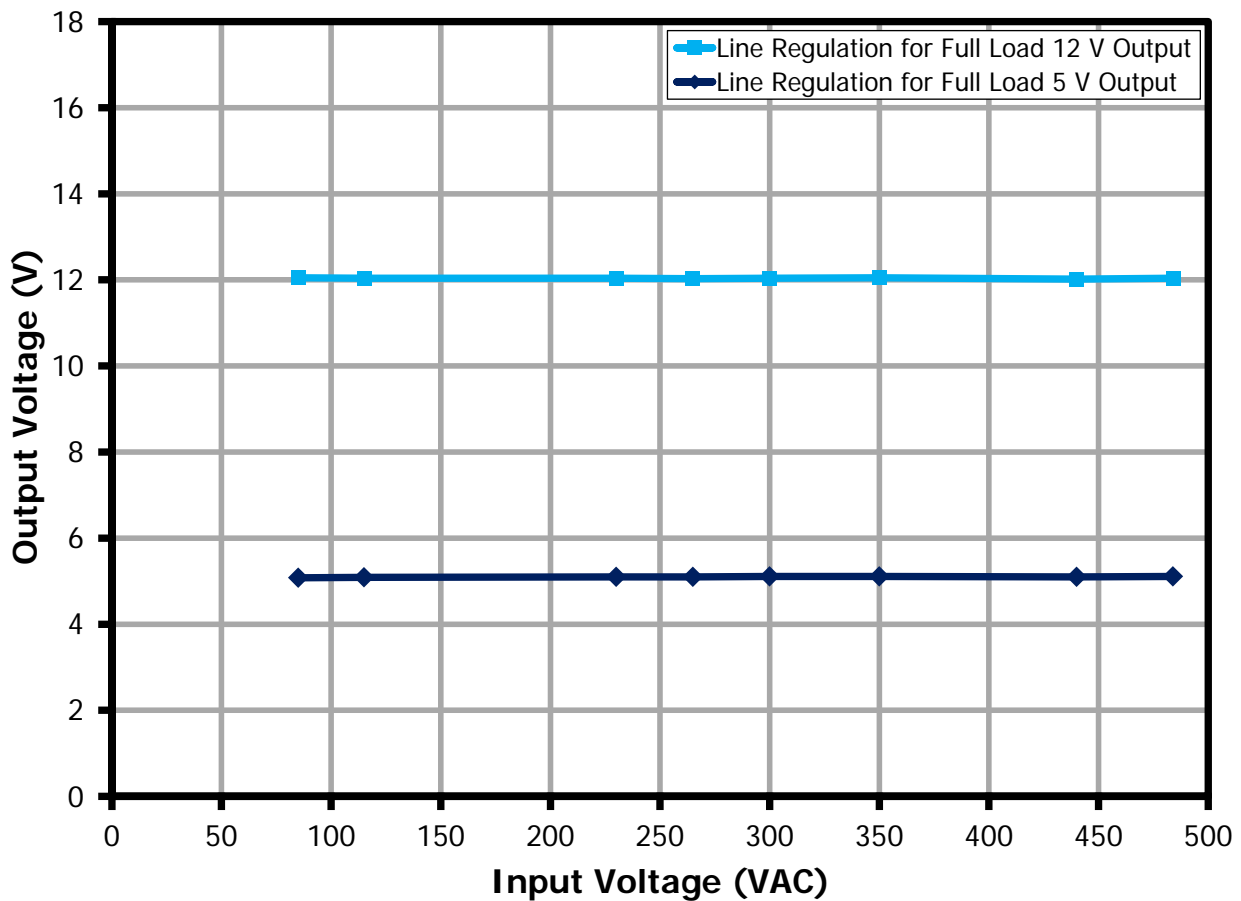


Figure 12 – Output Voltage vs. Input Line Voltage, Room Temperature.

10.3.2 Cross Load Regulation

10.3.2.1 12 V Output (No-Load) Across the Line with Full Load on 5 V

| VAC | V _{OUT} (12 V) | I _{OUT} (12 V) | V _{OUT} (5V) | I _{OUT} (5 V) |
|-----|-------------------------|-------------------------|-----------------------|------------------------|
| 85 | 13.6 | No Load | 5 | 0.5 |
| 115 | 13.52 | No Load | 4.99 | 0.5 |
| 230 | 13.56 | No Load | 4.99 | 0.5 |
| 265 | 13.57 | No Load | 5.01 | 0.5 |
| 300 | 13.52 | No Load | 4.98 | 0.5 |
| 350 | 13.55 | No Load | 4.99 | 0.5 |
| 440 | 13.51 | No Load | 4.98 | 0.5 |
| 484 | 13.56 | No Load | 5.01 | 0.5 |

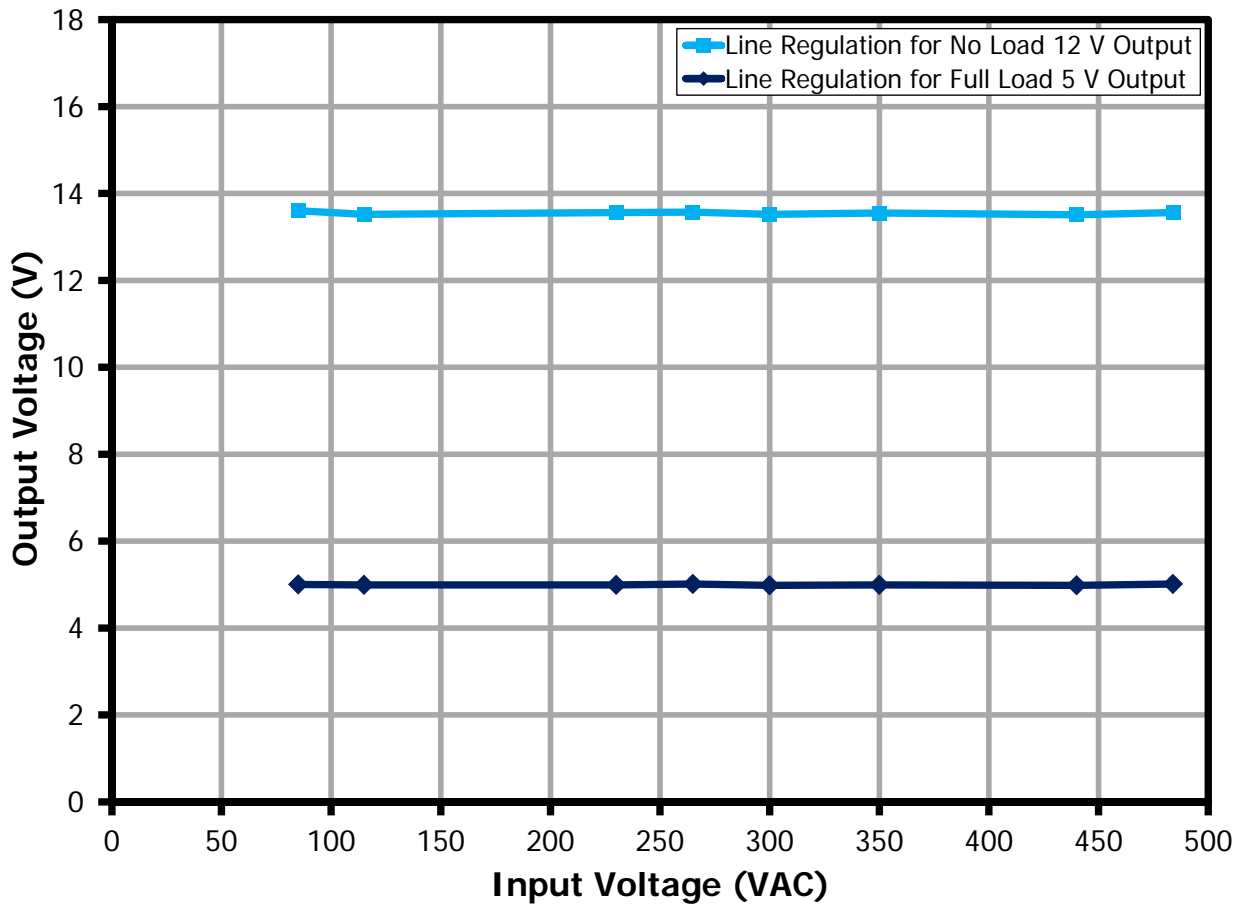


Figure 13 – 12 V Output Voltage vs. No Load, Room Temperature.



10.3.2.2 12 V Output (No Load) Across the Line with No-Load on 5 V

| VAC | V _{OUT} (12 V) | I _{OUT} (12 V) | V _{OUT} (5V) | I _{OUT} (5 V) |
|-----|-------------------------|-------------------------|-----------------------|------------------------|
| 85 | 12.92 | No Load | 5.07 | No Load |
| 115 | 12.93 | No Load | 5.07 | No Load |
| 230 | 12.95 | No Load | 5.07 | No Load |
| 265 | 12.94 | No Load | 5.05 | No Load |
| 300 | 12.94 | No Load | 5.05 | No Load |
| 350 | 12.96 | No Load | 5.06 | No Load |
| 440 | 12.95 | No Load | 5.06 | No Load |
| 484 | 12.91 | No Load | 5.06 | No Load |

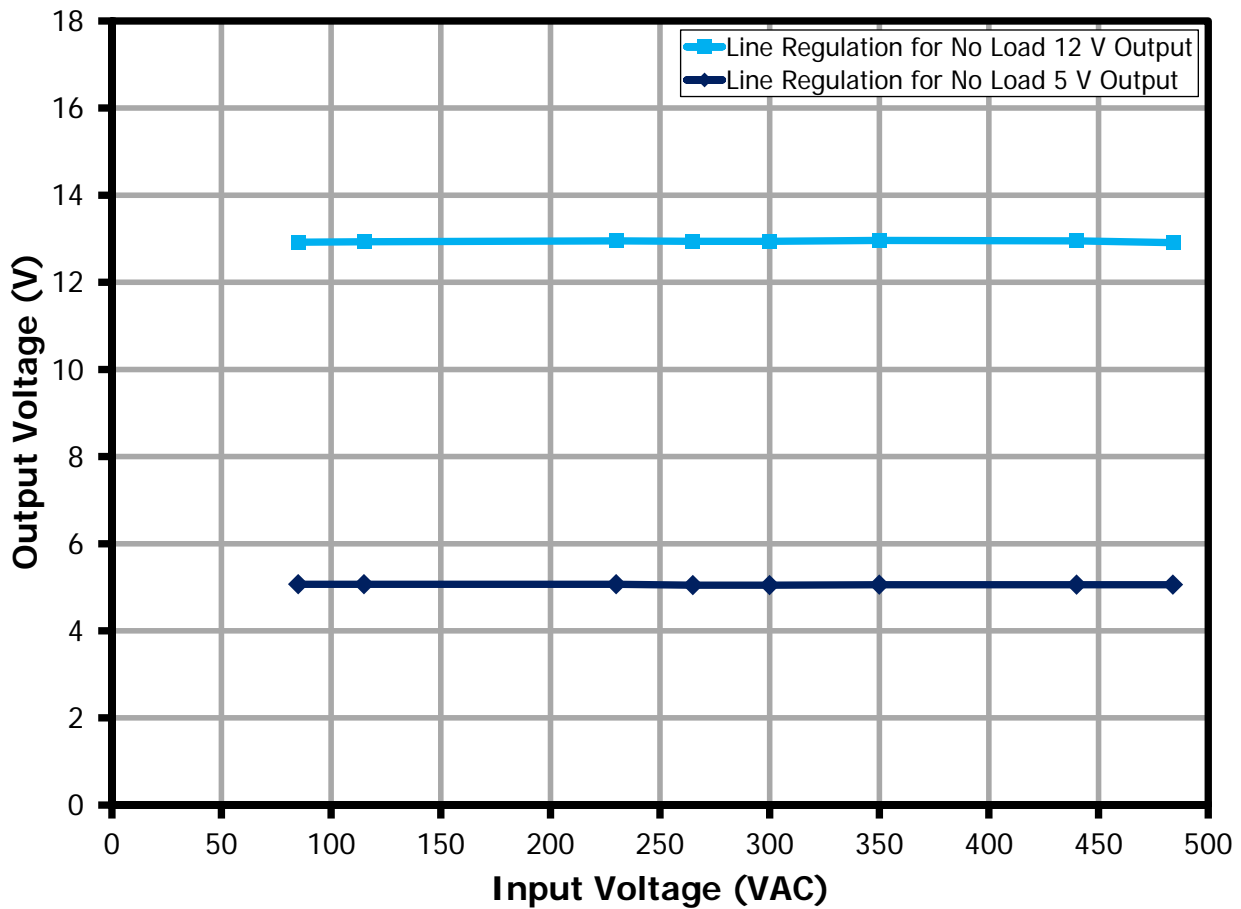


Figure 14 – 12 V Output Voltage vs. Output Load, Room Temperature.

10.3.2.3 12 V Output (Full Load Load) Across the Line with No-Load on 5 V

| VAC | V _{OUT} (12 V) | I _{OUT} (12 V) | V _{OUT} (5V) | I _{OUT} (5 V) |
|-----|-------------------------|-------------------------|-----------------------|------------------------|
| 85 | 11.72 | 1.243 | 5.15 | No Load |
| 115 | 11.74 | 1.243 | 5.15 | No Load |
| 230 | 11.73 | 1.243 | 5.17 | No Load |
| 265 | 11.72 | 1.243 | 5.18 | No Load |
| 300 | 11.61 | 1.243 | 5.16 | No Load |
| 350 | 11.66 | 1.243 | 5.14 | No Load |
| 440 | 11.69 | 1.243 | 5.18 | No Load |
| 484 | 11.7 | 1.243 | 5.18 | No Load |

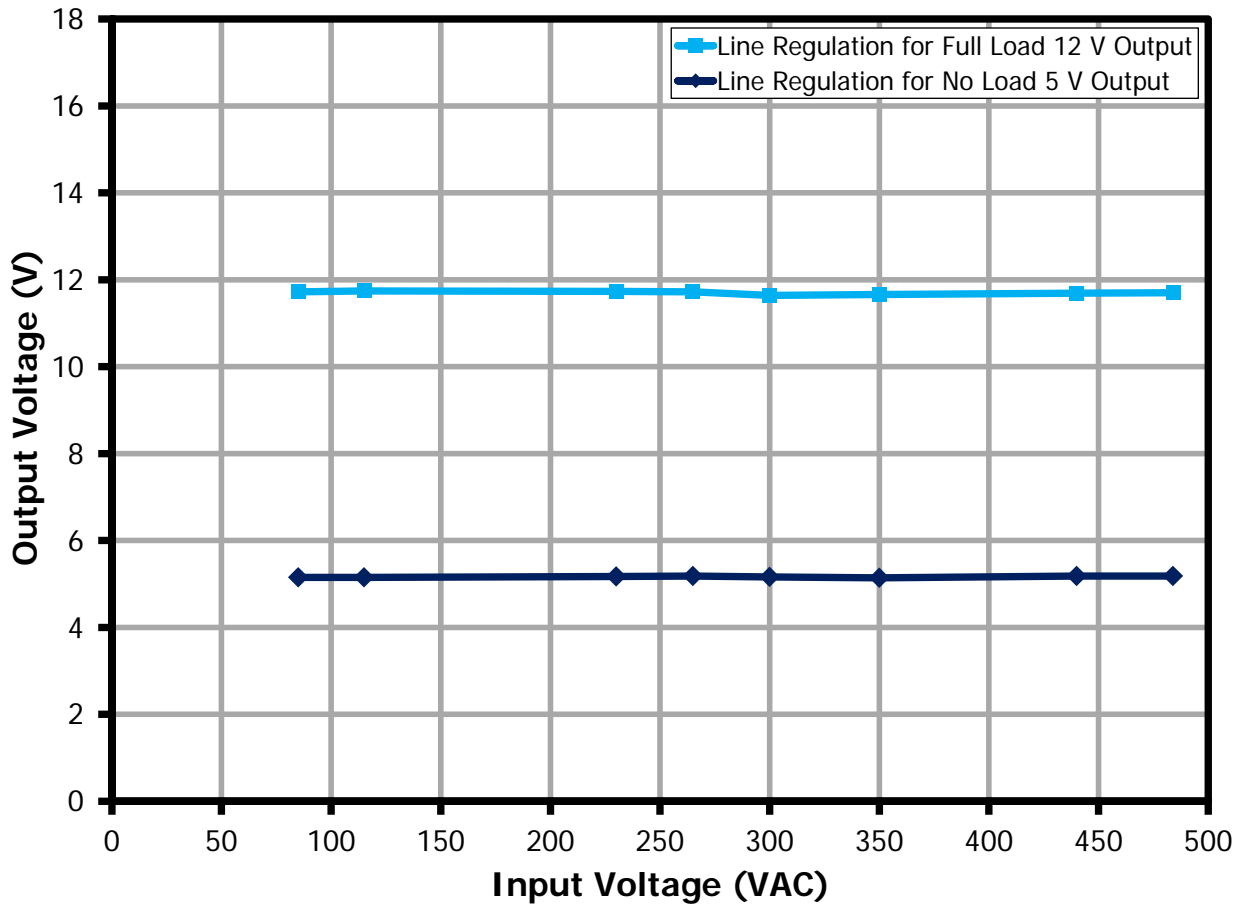


Figure 15 – 12 V Output Voltage vs. Output Load, Room Temperature.



11 Thermal Performance

11.1 85 VAC

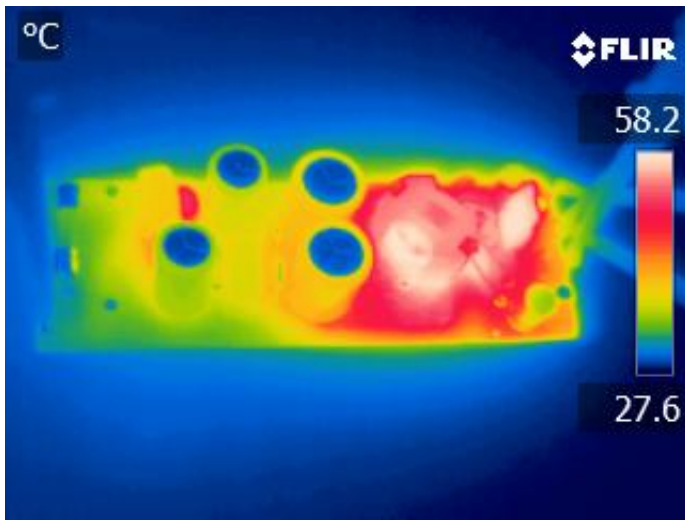


Figure 16 – Transformer Side. 85 VAC, Full Load.

| | Reference | °C |
|------------------|-----------|------|
| Ambient | | 26.2 |
| Transformer | T1 | 55.1 |
| Input Capacitor | C17 | 41 |
| Input Capacitor | C18 | 40.7 |
| Bridge Rectifier | BR1 | 51.9 |
| Thermistor | RT1 | 51.2 |

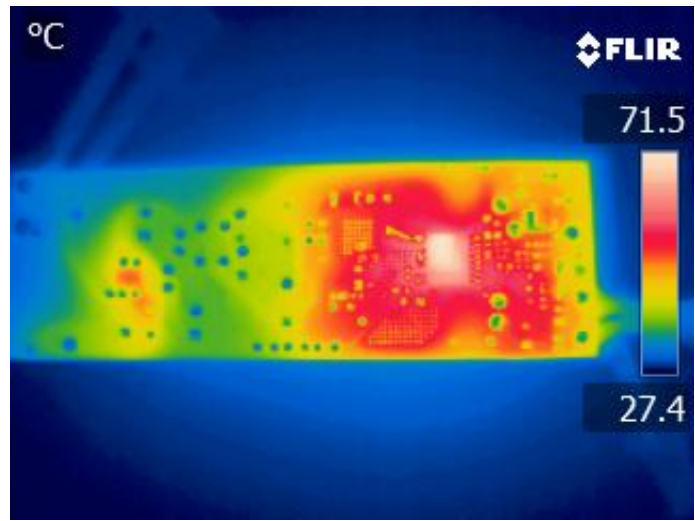


Figure 17 – InnoSwitch-EP Side. 85 VAC, Full Load.

| | Reference | °C |
|---------------|-----------|------|
| Ambient | | 26.2 |
| InnoSwitch-EP | U1 | 71.5 |
| SR FET Q1 | Q1 | 58 |
| SR FET Q2 | Q2 | 51.5 |

11.2 484 VAC

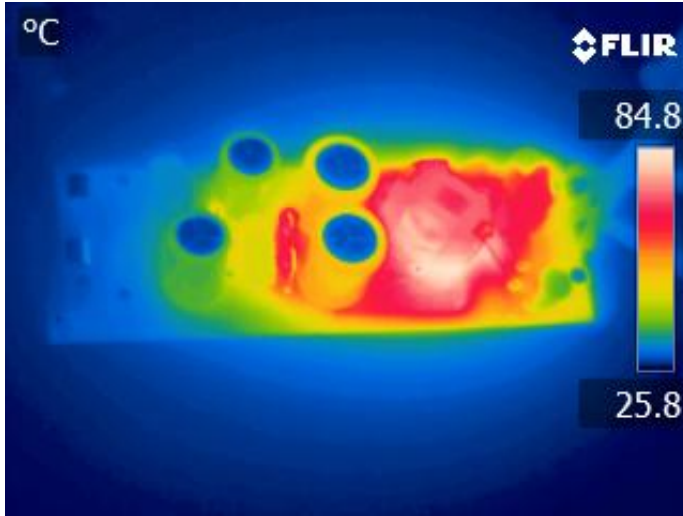


Figure 18 – Transformer Side. 265 VAC, Full Load.

| | Reference | °C |
|------------------|-----------|------|
| Ambient | | 27.1 |
| Transformer | T1 | 76.1 |
| Input Capacitor | C17 | 55.9 |
| Input Capacitor | C18 | 55.2 |
| Bridge Rectifier | BR1 | 43.6 |

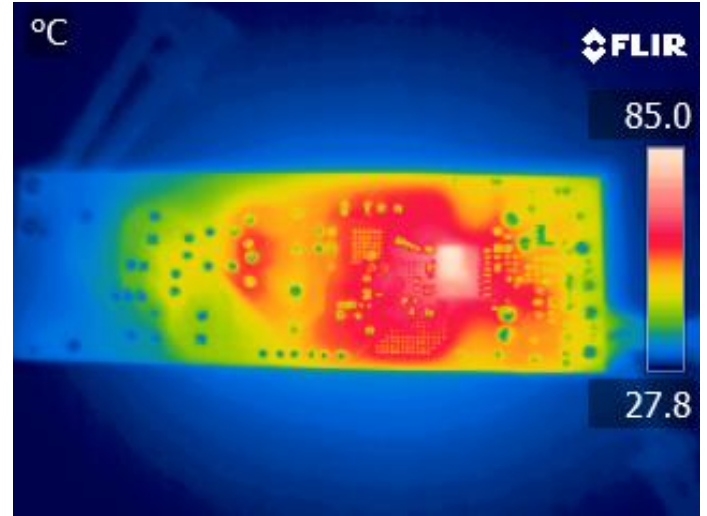


Figure 19 – InnoSwitch-EP Side. 265 VAC, Full Load.

| | Reference | °C |
|---------------|-----------|------|
| Ambient | | 27.1 |
| InnoSwitch-EP | U1 | 85 |
| SR FET Q1 | Q1 | 69.2 |
| SR FET Q2 | Q2 | 55.6 |

12 Output Power vs. Thermal Rise at 85° Ambient for Different AC Input Voltages

| Input Voltage(VAC) | Output Power(W) | T(amb) in (°C) | T(Inno) in (°C) | dT(Rise) |
|--------------------|-----------------|----------------|-----------------|----------|
| 484 | 5.8 | 85.5 | 109.8 | 24.3 |
| 440 | 6.94 | 85.2 | 110.1 | 24.9 |
| 350 | 9.54 | 85.1 | 109.2 | 24.1 |
| 265 | 11.4 | 85.2 | 109 | 23.8 |
| 85 | 10.12 | 85.5 | 109.5 | 24 |

Note: All the measurements are done using thermo couples.

13 Waveforms

13.1 Load Transient Response

13.1.1 5 V Load Transient (No-Load to Full Load) and No-Load on 12 V Output

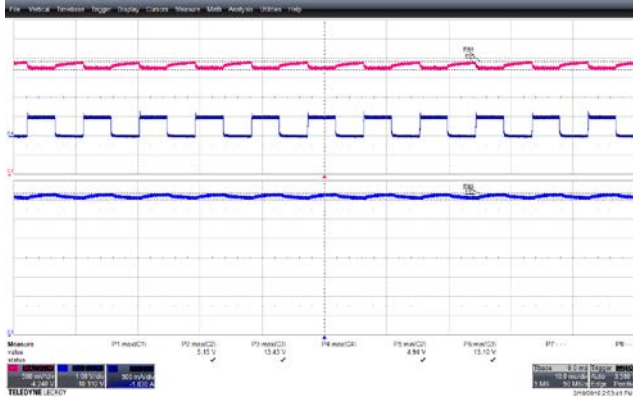


Figure 20 – 0.0 A – 0.5 A, 5 V Load Step Transient Response, 85 VAC.
 5 V_{MIN}: 4.94 V.
 5 V_{MAX}: 5.15 V.
 12 V_{MIN}: 13.10 V.
 12 V_{MAX}: 13.43 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 5 V Load, 0.5 A, 10 ms / div.
 Lower: 12 V_{OUT}, 1 V / div.

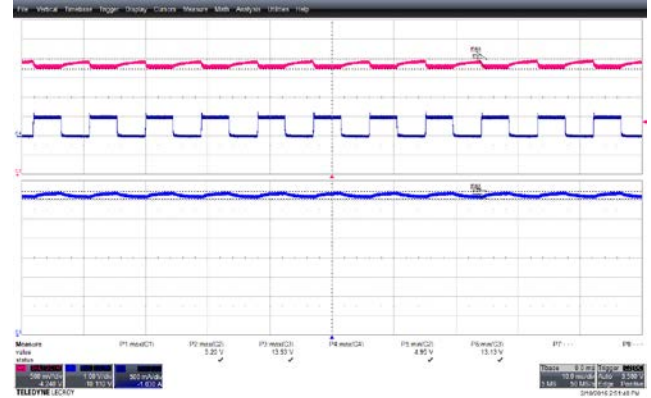


Figure 21 – 0.0 A – 0.5 A, 5 V Load Step Transient Response, 484 VAC.
 5 V_{MIN}: 4.95 V.
 5 V_{MAX}: 5.20 V.
 12 V_{MIN}: 13.13 V.
 12 V_{MAX}: 13.53 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 5 V Load, 0.5 A, 10 ms / div.
 Lower: 12 V_{OUT}, 1 V / div.

13.1.2 5 V Load Transient (No-Load to Full Load) and Full Load on 12 V Output

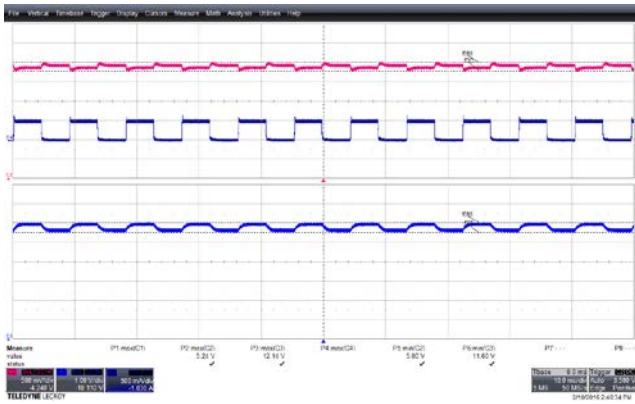


Figure 22 – 0.0 A – 0.5 A, 5 V Load Step Transient Response, 85 VAC.
 5 V_{MIN}: 5.00 V.
 5 V_{MAX}: 5.24 V.
 12 V_{MIN}: 11.60 V.
 12 V_{MAX}: 12.14 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 5 V Load, 0.5 A, 10 ms / div.
 Lower: 12 V_{OUT}, 1 V / div.

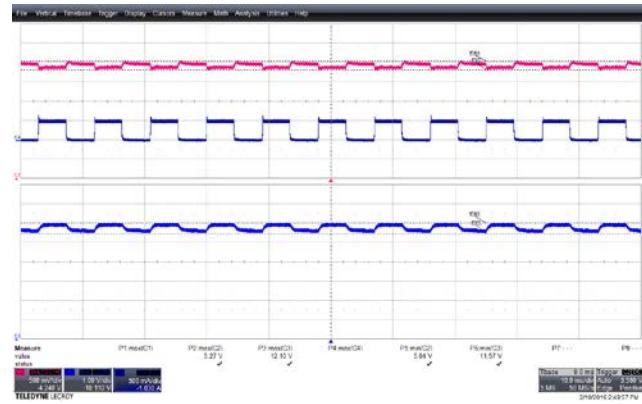


Figure 23 – 0.0 A – 0.5 A, 5 V Load Step Transient Response, 484 VAC.
 5 V_{MIN}: 5.04 V.
 5 V_{MAX}: 5.27 V.
 12 V_{MIN}: 11.57 V.
 12 V_{MAX}: 12.10 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 5 V Load, 0.5 A, 10 ms / div.
 Lower: 12 V_{OUT}, 1 V / div.

13.1.3 12 V Load Transient (No-Load to Full Load) and No-Load on 5 V Output

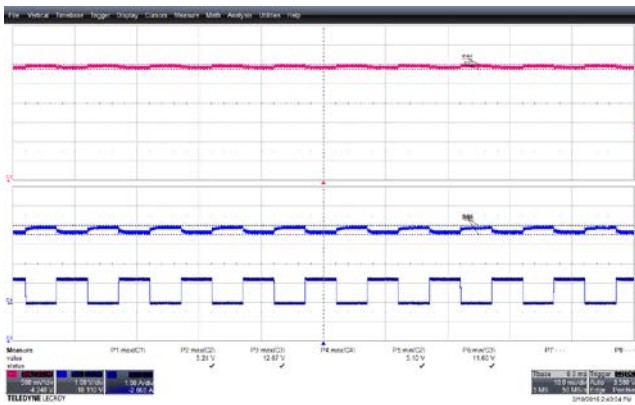


Figure 24 – 0.0 A – 1.25 A, 12 V Load Step Transient Response, 85 VAC.
 5 V_{MIN}: 5.10 V.
 5 V_{MAX}: 5.24 V.
 12 V_{MIN}: 11.64 V.
 12 V_{MAX}: 12.07 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 12 V_{OUT}, 1 V / div.
 Lower: 12 V Load, 1 A, 10 ms / div.

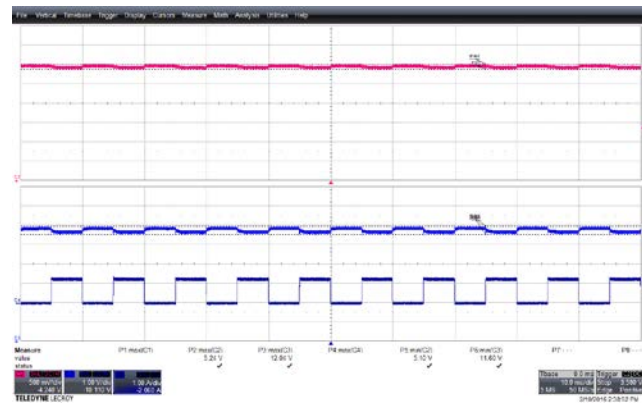


Figure 25 – 0.0 A – 1.25 A, 12 V Load Step Transient Response, 484 VAC.
 5 V_{MIN}: 5.10 V.
 5 V_{MAX}: 5.24 V.
 12 V_{MIN}: 11.60 V.
 12 V_{MAX}: 12.04 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 12 V_{OUT}, 1 V / div.
 Lower: 12 V Load, 1 A, 10 ms / div.

13.1.4 12 V Load Transient (No-Load to Full Load) and Full Load on 5 V Output

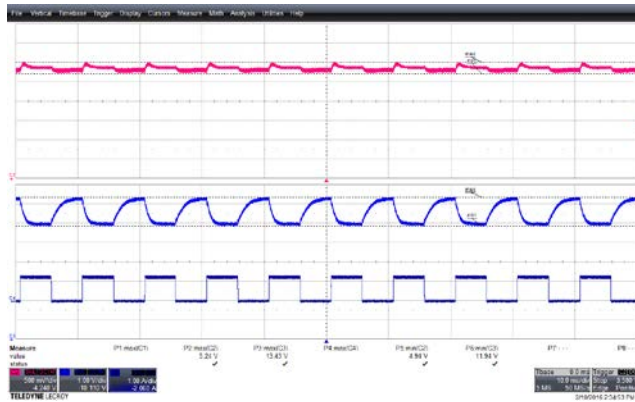


Figure 26 – 0.0 A – 1.25 A, 12 V Load Step Transient Response, 85 VAC.
 5 V_{MIN}: 4.94 V.
 5 V_{MAX}: 5.24 V.
 12 V_{MIN}: 11.94 V.
 12 V_{MAX}: 13.43 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 12 V_{OUT}, 1 V / div.
 Lower: 12 V Load, 1 A, 10 ms / div.

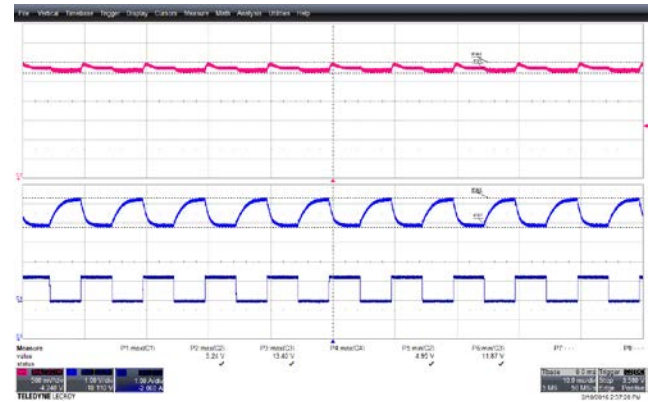


Figure 27 – 0.0 A – 1.25 A, 12 V Load Step Transient Response, 484 VAC.
 5 V_{MIN}: 4.95 V.
 5 V_{MAX}: 5.24 V.
 12 V_{MIN}: 11.87 V.
 12 V_{MAX}: 13.40 V.
 Upper: 5 V_{OUT}, 0.5 V / div.
 Middle: 12 V_{OUT}, 1 V / div.
 Lower: 12 V Load, 1 A, 10 ms / div.

13.2 Switching Waveforms

13.2.1 InnoSwitch-EP Waveforms

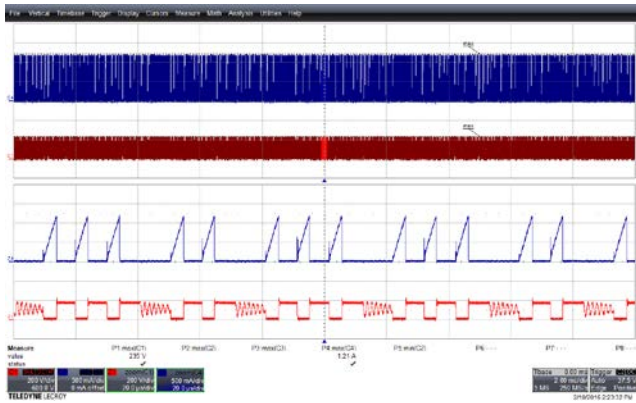


Figure 28 – Drain Voltage and Current Waveforms.
85 VAC Input, Full Load.
Upper: V_{DRAIN} , 200 V, 2 ms, 20 μ s / div.
Lower: I_{DRAIN} , 500 mA / div.

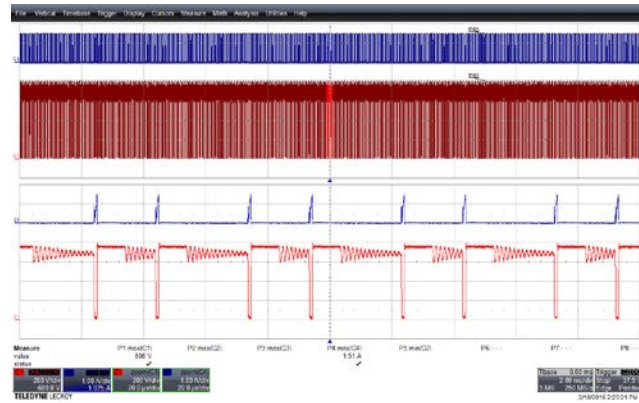


Figure 29 – Drain Voltage and Current Waveforms.
484 VAC Input, Full Load,
(Max V_{DRAIN} : 806 V.)
Upper: V_{DRAIN} , 200 V, 2 ms, 10 μ s / div.
Lower: I_{DRAIN} , 1000 mA / div.

13.2.2 SR FET Waveforms

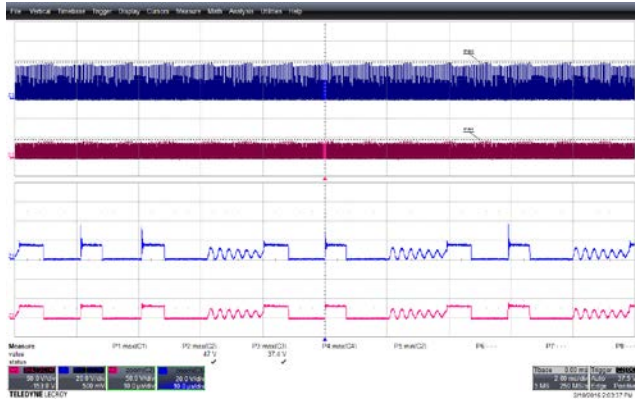


Figure 30 – SR FET Voltage Waveforms.
 85 VAC Input, Full Load.
 Upper: 5 V, 20 V /, 2 ms, 10 µs / div.
 Lower: 12 V, 50 V / div.

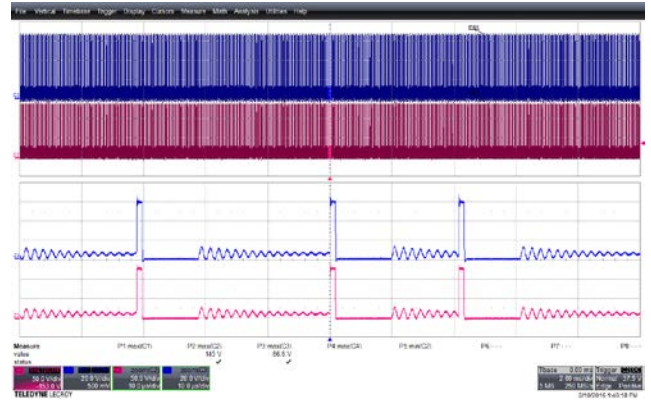


Figure 31 – SR FET Voltage Waveforms.
 484 VAC Input, Full Load.
 (143 V_{MAX} for 12 V, 66.6 V_{MAX} for 5 V.)
 Upper: 5 V, 20 V /, 2 ms, 10 µs / div.
 Lower: 12 V, 50 V / div.



13.2.3 Output Voltage and Current Waveforms During Start-Up

13.2.3.1 Full load

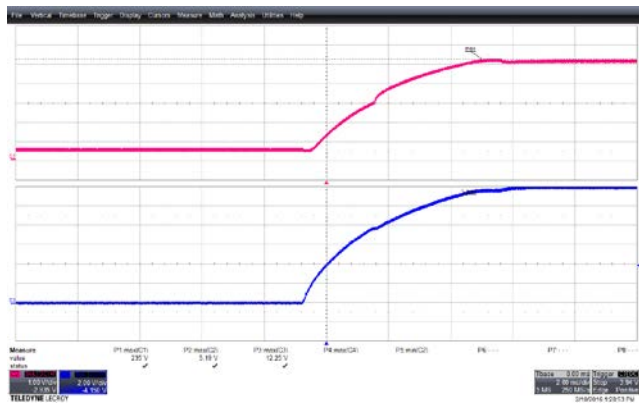


Figure 32 – Output Voltage Waveforms.
85 VAC Input.
Upper: 5 V, 1 V / div.
Lower: 12 V, 2 V / div, 2 ms / div.

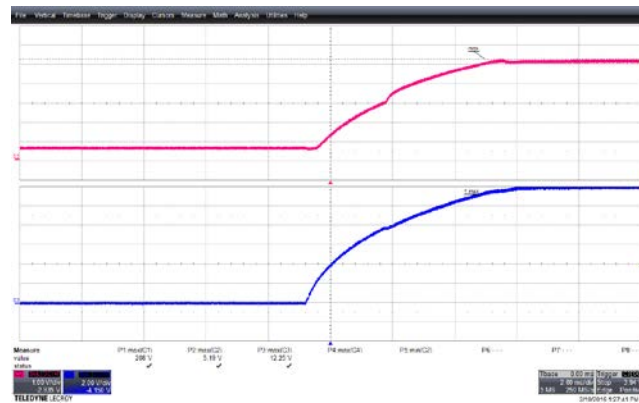


Figure 33 – Output Voltage Waveforms.
484 VAC Input.
Upper: 5 V, 1 V / div.
Lower: 12 V, 2 V / div., 2 ms / div.

13.2.3.2 No-Load

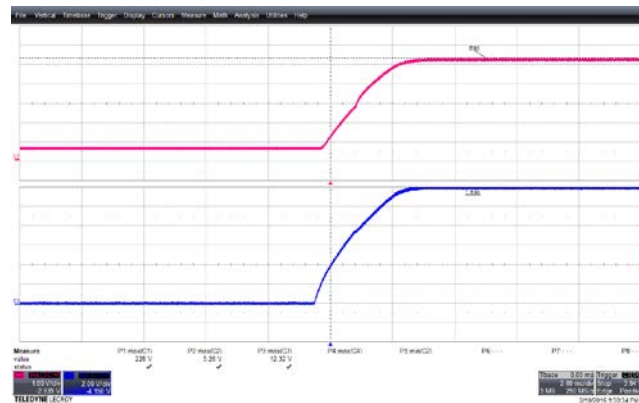


Figure 34 – Output Voltage Waveforms.
85 VAC Input.
Upper: 5 V, 1 V / div.
Lower: 12 V, 2 V / div., 2 ms / div.

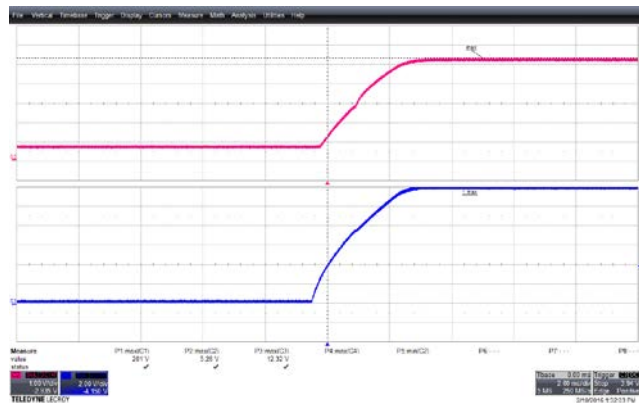


Figure 35 – Output Voltage Waveforms.
484 VAC Input.
Upper: 5 V, 1 V / div.
Lower: 12 V, 2 V / div., 2 ms / div.

13.3 Output Ripple Measurements

13.3.1 Ripple Measurement Technique

For DC output ripple measurements, a modified oscilloscope test probe must be utilized in order to reduce spurious signals due to pick-up. Details of the probe modification are provided in the Figures below.

The 4987BA probe adapter is affixed with two capacitors tied in parallel across the probe tip. The capacitors include one (1) 0.1 $\mu\text{F}/50\text{ V}$ ceramic type and one (1) 1 $\mu\text{F}/50\text{ V}$ aluminum electrolytic. The aluminum electrolytic type capacitor is polarized, so proper polarity across DC outputs must be maintained (see below).

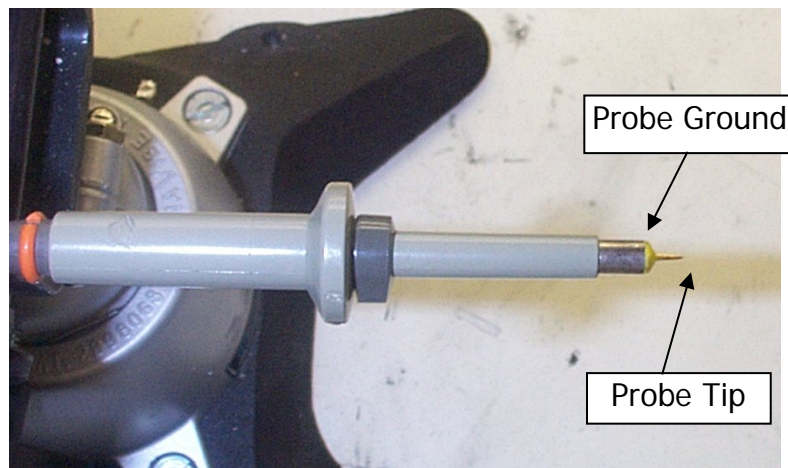


Figure 36 – Oscilloscope Probe Prepared for Ripple Measurement. (End Cap and Ground Lead Removed)



Figure 37 – Oscilloscope Probe with Probe Master (www.probemaster.com) 4987A BNC Adapter. (Modified with wires for ripple measurement, and two parallel decoupling capacitors added)

13.3.2 Ripple Voltage Waveforms

13.3.2.1 0.5 A Load on 5 V and 1.25 A Load on 12 V

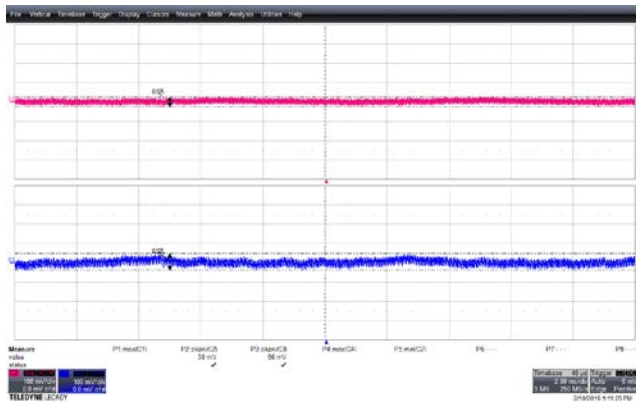


Figure 38 – Output Voltage Ripple Waveforms.
 85 VAC Input. 1.25 A on 12 V.
 5 V_{PK}: 50 mV, 12 V_{PK}: 86 mV.
 Upper: 5 V, 100 mV / div.
 Lower: 12 V, 100 mV, 2 ms / div.

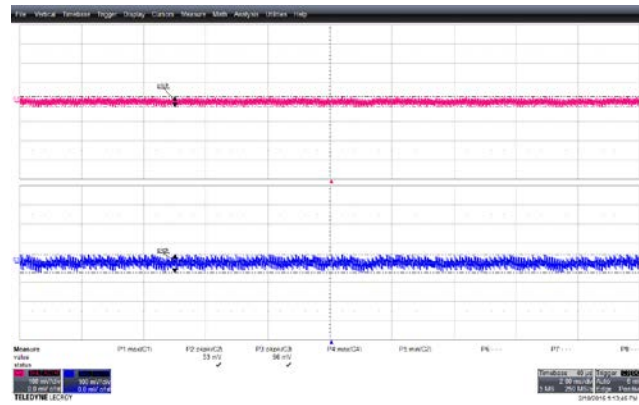


Figure 39 – Output Ripple Voltage Waveforms.
 265 VAC Input. 1.25 A on 12 V.
 5 V_{PK}: 53 mV, 12 V_{PK}: 96 mV.
 Upper: 5 V, 100 mV / div.
 Lower: 12 V, 100 mV, 2 ms / div.

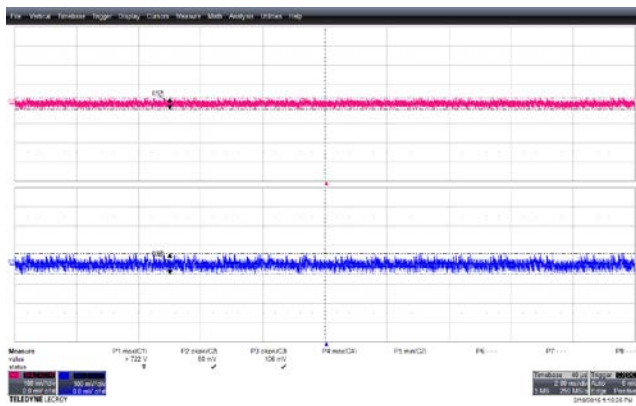


Figure 40 – Output Ripple Voltage Waveforms.
 440 VAC Input. 1.25 A on 12 V.
 5 V_{PK}: 60 mV, 12 V_{PK}: 106 mV.
 Upper: 5 V, 100 mV / div.
 Lower: 12 V, 100 mV, 2 ms / div.

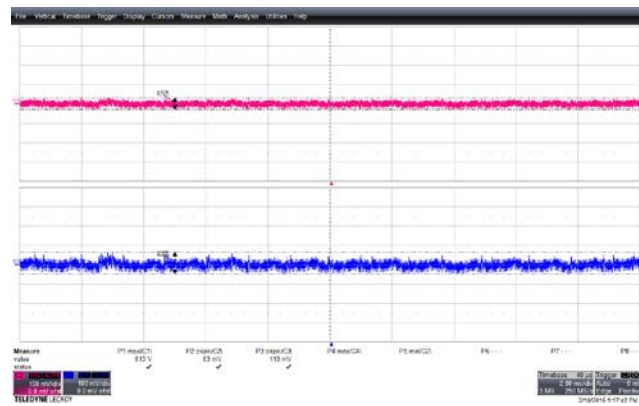


Figure 41 – Output Ripple Voltage Waveforms.
 484 VAC Input. 1.25 A on 12 V.
 5 V_{PK}: 63 mV, 12 V_{PK}: 113 mV.
 Upper: 5 V, 100 mV / div.
 Lower: 12 V, 100 mV, 2 ms / div..

13.4 Line Undervoltage and Overvoltage (DC Input)

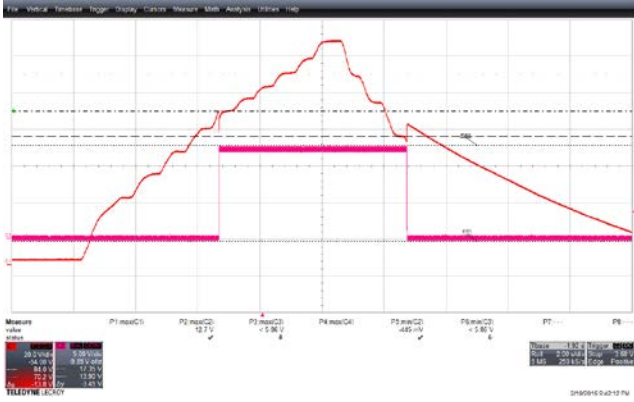


Figure 42 – Line Undervoltage.
 DC Input.
 V_{UV+} : 84.0 V, V_{UV-} : 70.2 V.
 Upper (Output Voltage): 12 V, 5 V / div.
 Lower: Voltage across C1 & C2, 20 V, 2 s / div.

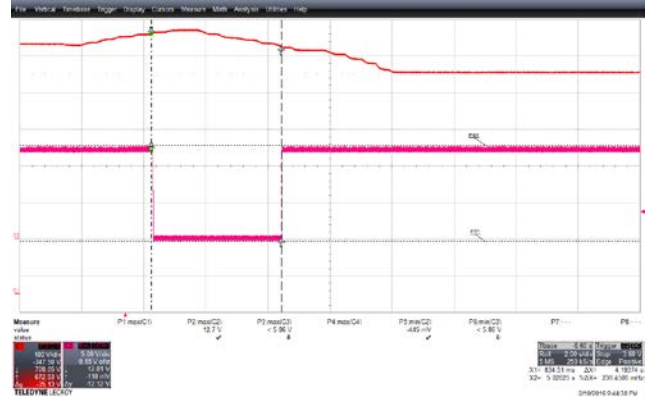


Figure 43 – Line Overvoltage.
 DC Input, No-Load.
 V_{OV+} : 708 V, V_{OV-} : 673 V.
 Upper: 12 V, 5 V / div.
 Lower: Voltage across C1 & C2, 100 V, 2 s / div.



14 ESD

Passed ±16.5 kV air discharge and 8 kV contact discharge.

| Air discharge (kV) | Number of Strikes | Test Result |
|--------------------|-------------------|-------------|
| +16.5 KV | 10 | PASS |
| -16.5 KV | 10 | PASS |

| Contact discharge (kV) | Number of Strikes | Test Result |
|------------------------|-------------------|-------------|
| +8 KV | 10 | PASS |
| -8 KV | 10 | PASS |

15 EMI

15.1 Conductive EMI

15.1.1 Earth Grounded Output (QP / AV)

15.1.1.1 110 VAC Input, Neutral

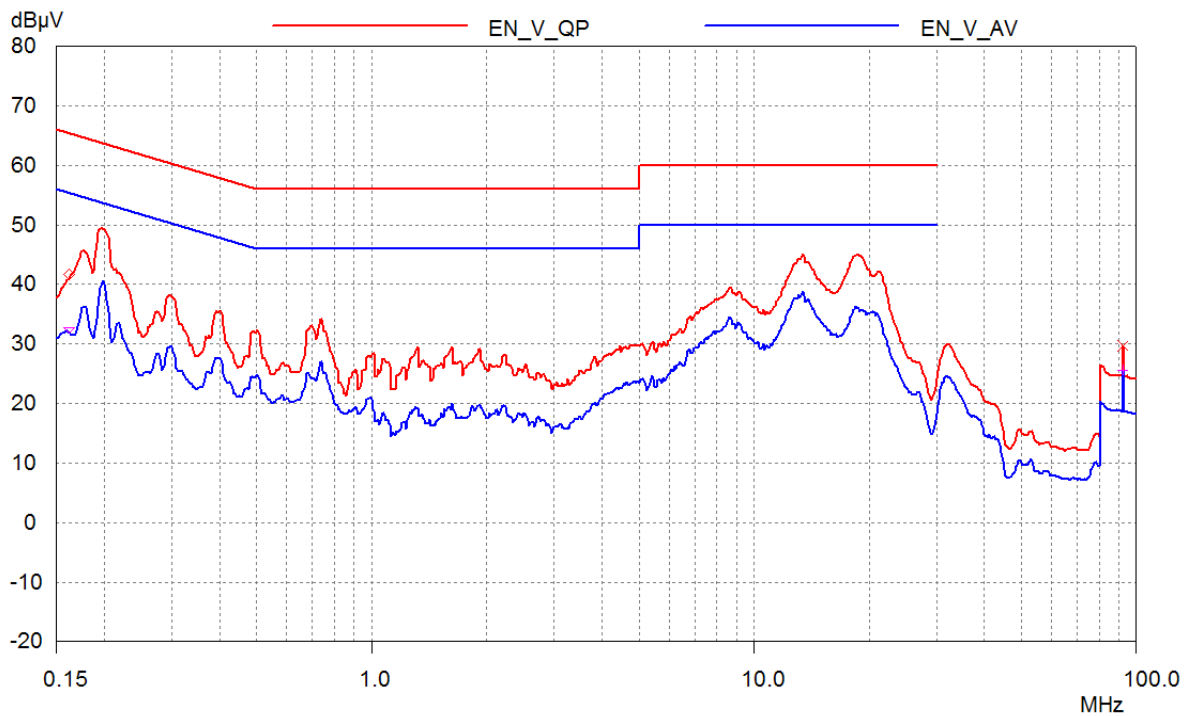


Figure 44 – Earth Ground at 110 VAC, Neutral.

15.1.1.2 110 VAC Input, Line

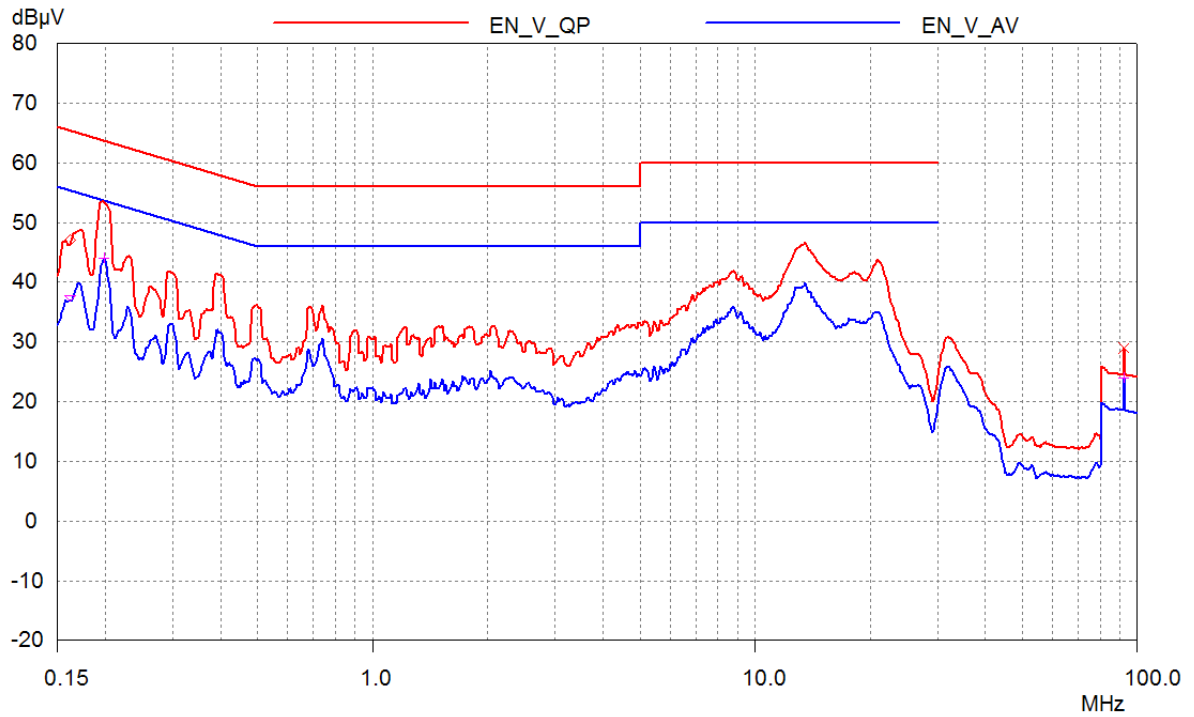


Figure 45 – Earth Ground at 110 VAC, Line.



15.1.1.3 230 VAC Input, Neutral

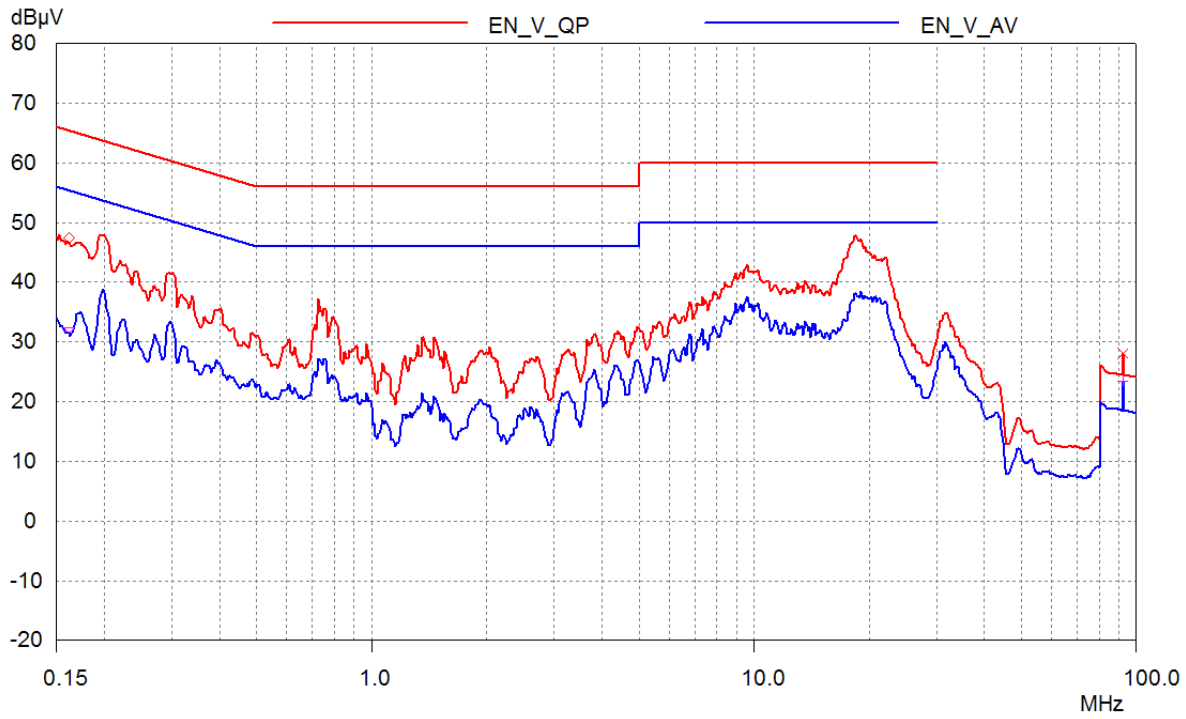


Figure 46 – Earth Ground at 230 VAC, Neutral.

15.1.1.4 230 VAC Input, Line

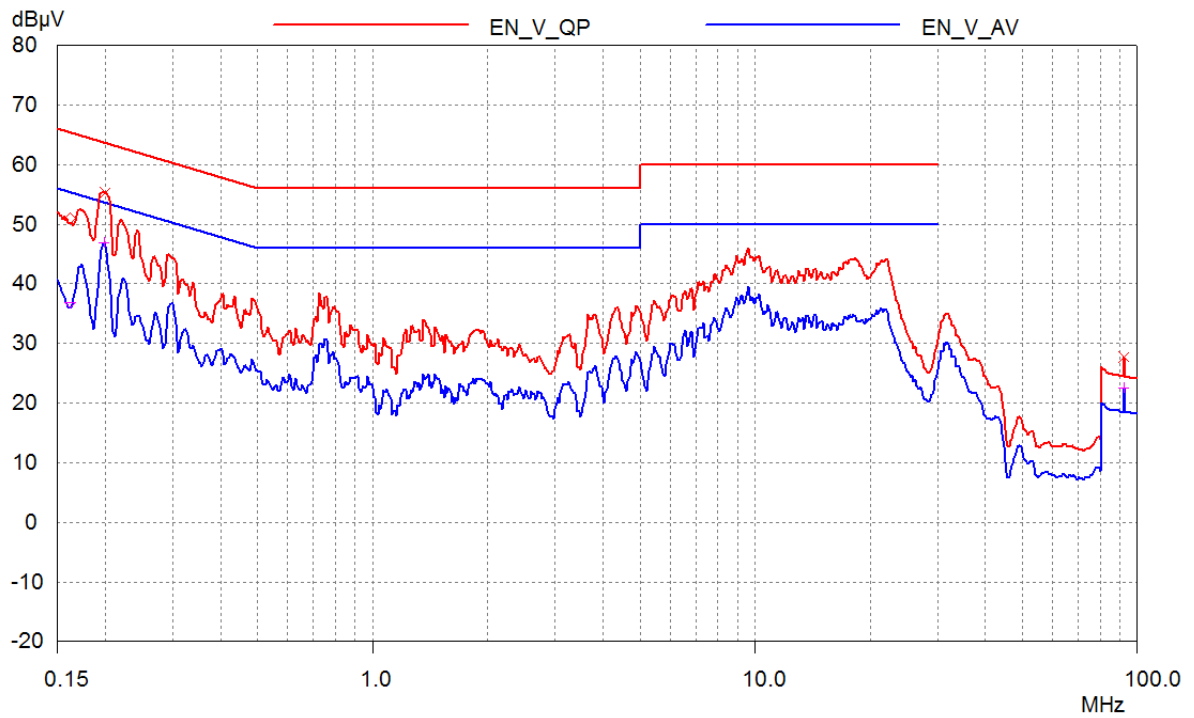


Figure 47 – Earth Ground at 230 VAC, Line.



16 Lighting Surge Test

16.1 *Combination Wave Differential Mode Test*

Passed ± 2 kV.

| Surge Voltage (kV) | Phase Angle (°) | Generator Impedance (W) | Number of Strikes | Test Result |
|--------------------|-----------------|-------------------------|-------------------|-------------|
| ± 2 | 0 | 2 | 10 | PASS |
| ± 2 | 90 | 2 | 10 | PASS |
| ± 2 | 180 | 2 | 10 | PASS |
| ± 2 | 270 | 2 | 10 | PASS |

16.2 *Ring Wave Common Mode Test*

Passed ± 6 kV.

| Ring Wave Voltage (kV) | Phase Angle (°) | Generator Impedance (W) | Number of Strikes | Test Result |
|------------------------|-----------------|-------------------------|-------------------|-------------|
| ± 6 | 0 | 12 | 10 | PASS |
| ± 6 | 90 | 12 | 10 | PASS |
| ± 6 | 180 | 12 | 10 | PASS |
| ± 6 | 270 | 12 | 10 | PASS |

17 Revision History

| Date | Author | Revision | Description & Changes | Reviewed |
|-------------|---------------|-----------------|---|-----------------|
| 22-Mar-16 | SK | 1.0 | Initial Release. | Apps & Mktg |
| 13-Apr-16 | KM | 1.1 | Updated Schematic. | |
| 12-Jul-16 | KM | 1.2 | Added Magnetics Supplier | |
| 07-Sep-16 | KM | 1.3 | Changed to RDR, Updated Transformer and CMC Documentation | |



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